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# ADC10D1000/ADC10D1500 Low Power, 10-Bit, Dual 1.0/1.5 GSPS or Single 2.0/3.0 GSPS **ADC**

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#### **FEATURES**

- **Excellent Accuracy and Dynamic Performance**
- Pin Compatible with ADC12D1000/1600/1800

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- Low Power Consumption, Further Reduced at Lower Fs
- Internally Terminated, Buffered, Differential **Analog Inputs**
- R/W SPI Interface for Extended Control Mode
- Dual-Edge Sampling Mode, in Which the I- and Q-channels Sample One Input at Twice the Sampling Clock Rate
- Test Patterns at Output for System Debug
- Programmable 15-bit Gain and 12-bit Plus Sign Offset
- Programmable t<sub>AD</sub> Adjust Feature
- 1:1 Non-demuxed or 1:2 Demuxed LVDS **Outputs**
- **AutoSync Feature for Multi-Chip Systems**
- Single 1.9V ± 0.1V Power Supply
- 292-Ball BGA Package (27mm x 27mm x 2.4mm with 1.27mm Ball-Pitch); No Heat Sink Required

#### **APPLICATIONS**

- **Wideband Communications**
- **Data Acquisition Systems**
- **Digital Oscilloscopes**

#### DESCRIPTION

The ADC10D1000/1500 is the latest advance in TI's Ultra-High-Speed ADC family. This low-power, highperformance CMOS analog-to-digital digitizes signals at 10-bit resolution for dual channels at sampling rates of up to 1.0/1.5 GSPS (Non-DES Mode) or for a single channel up to 2.0/3.0 GSPS (DES Mode). The ADC10D1000/1500 achieves excellent accuracy and dynamic performance while dissipating less than 2.8/3.6 Watts. The product is packaged in a leaded or lead-free 292-ball thermally enhanced BGA package over the rated industrial temperature range of -40°C to +85°C.

The ADC10D1000/1500 builds upon the features, architecture and functionality of the 8-bit GHz family of ADCs. An expanded feature set includes AutoSync for multi-chip synchronization, 15-bit programmable gain and 12-bit plus sign programmable offset adjustment for each channel. The improved internal track-and-hold amplifier and the extended selfcalibration scheme enable a very flat response of all dynamic parameters beyond Nyquist, producing 9.1/9.0 Effective Number of Bits (ENOB) with a 100 MHz input signal and a 1.0/1.5 GHz sample rate while providing a 10<sup>-18</sup> Code Error Rate (CER) Dissipating a typical 2.77/3.59 Watts in Non-Demultiplex Mode at 1.0/1.5 GSPS from a single 1.9V supply, this device is specified to have no missing codes over the full operating temperature range.

Each channel has its own independent DDR Data Clock, DCLKI and DCLKQ, which are in phase when both channels are powered up, so that only one Data Clock could be used to capture all data, which is sent out at the same rate as the input sample clock. If the 1:2 Demux Mode is selected, a second 10-bit LVDS bus becomes active for each channel, such that the output data rate is sent out two times slower to relax data-capture timing requirements. The part can also be used as a single 2.0/3.0 GSPS ADC to sample one of the I or Q inputs. The output formatting can be programmed to be offset binary or two's complement and the Low Voltage Differential Signaling (LVDS) digital outputs are compatible with IEEE 1596.3-1996, with the exception of an adjustable common mode voltage between 0.8V and 1.2V to allow for power reduction for well-controlled back planes.

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### **Table 1. Key Specifications**

(Non-Demux No	on-DES Mode, Fs=1.0/1.5 GSPS, Fin = 100 MHz)		
Resolution		10 Bits	
Conversion Rate	Conversion Rate		
	Dual channels at 1.0/1.5 GSPS (typ)		
	Single channel at 2.0/3.0 GSPS (typ)		
Code Error Rate	)	10 <sup>-18</sup> /10 <sup>-18</sup> (typ)	
ENOB		9.1/9.0 bits (typ)	
SNR		57/56.8 dB (typ)	
SFDR		70/68 dBc (typ)	
Full Power Band	dwidth	2.8/2.8 GHz (typ)	
DNL		±0.25/±0.25 LSB (typ)	
Power Consump	ption	·	
	Single Channel Enabled	1.61/1.92 W (typ)	
	Dual Channels Enabled	2.77/3.59 W (typ)	
	Power Down Mode	6/6 mW (typ)	

## Table 2. Ordering Information (1)(2)

Industrial Temperature Range (-40°C < T <sub>A</sub> < 85°C)	Package
ADC10D1000/1500CIUT/NOPB	Lead-free 292-Ball BGA Thermally Enhanced Package
ADC10D1000/1500CIUT	Leaded 292-Ball BGA Thermally Enhanced Package
ADC10D1000/1500RB	Reference Board

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

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2

<sup>(2)</sup> If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications. IBIS models are available at www.ti.com



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### **Block Diagram**

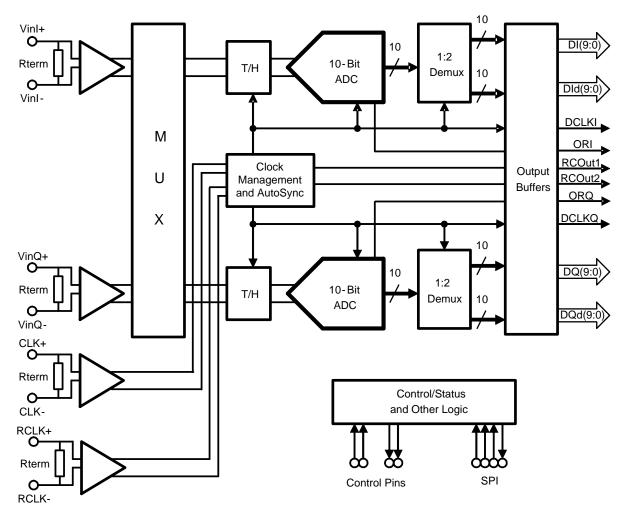


Figure 1. Simplified Block Diagram

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### **Connection Diagram**

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	
Α	GND	V_A	SDO	ТРМ	NDM	V_A	GND	V_E	GND_E	RSV0+	V_DR	Dld1+	GND_ DR	Dld4+	V_DR	Dld7+	GND_ DR	Dld9+	Dld9-	GND_ DR	Α
В	Vbg	GND	ECEb	SDI	CalRun	V_A	GND	GND_E	V_E	RSV0-	Dld0+	Dld1-	Dld3+	Dld4-	Dld6+	Dld7-	Dld8+	RSV2+	RSV3+	RSV3-	В
С	Rtrim+	Vcmo	Rext+	SCSb	SCLK	V_A	NC	V_E	GND_E	RSV1+	Dld0-	Dld2+	Dld3-	Dld5+	DId6-	Dld8-	RSV2-	V_DR	DI0+	DI0-	С
D	DNC	Rtrim-	Rext-	GND	GND	CAL	DNC	V_A	V_A	RSV1-	V_DR	Dld2-	GND_ DR	DId5-	V_DR	GND_ DR	V_DR	DI1+	DI2+	DI2-	D
E	V_A	Tdiode+	DNC	GND													GND_ DR	DI1-	DI3+	DI3-	E
F	V_A	GND _TC	Tdiode-	DNC													GND_ DR	DI4+	DI4-	GND_ DR	F
G	V_TC	GND _TC	v_тс	V_TC													DI5+	DI5-	DI6+	DI6-	G
Н	VinI+	v_тс	GND _TC	V_A				GND	GND	GND	GND	GND	GND				DI7+	DI7-	DI8+	DI8-	Н
J	Vinl-	GND _TC	V_TC	Vbiasl				GND	GND	GND	GND	GND	GND			_	V_DR	DI9+	DI9-	V_DR	J
ĸ	GND	Vbiasl	v_тс	GND _TC				GND	GND	GND	GND	GND	GND				ORI+	ORI-	DCLK _I+	DCLK _I-	ĸ
L	GND	VbiasQ	V_TC	GND _TC				GND	GND	GND	GND	GND	GND				ORQ+	ORQ-	DCLK _Q+	DCLK _Q-	L
M	VinQ-	GND _TC	V_TC	VbiasQ				GND	GND	GND	GND	GND	GND				GND_ DR	DQ9+	DQ9-	GND_ DR	М
N	VinQ+	V_TC	GND _TC	V_A				GND	GND	GND	GND	GND	GND				DQ7+	DQ7-	DQ8+	DQ8-	N
Р	V_TC	GND _TC	v_tc	V_TC			'										DQ5+	DQ5-	DQ6+	DQ6-	P
R	V_A	GND _TC	v_tc	V_TC													V_DR	DQ4+	DQ4-	V_DR	R
т	V_A	GND _TC	GND _TC	GND													V_DR	DQ1-	DQ3+	DQ3-	Т
U	GND _TC	CLK+	PDI	GND	GND	RCOut _1-	DNC	V_A	V_A	RSV7-	V_DR	DQd2-	GND_ DR	DQd5-	V_DR	V_DR	GND_ DR	DQ1+	DQ2+	DQ2-	U
٧	CLK-	DCLK _RST+	PDQ	CalDly	DES	RCOut _2+	RCOut _2-	V_E	GND_E	RSV7+	DQd0-	DQd2+	DQd3-	DQd5+	DQd6-	DQd8-	RSV4-	GND_ DR	DQ0+	DQ0-	٧
w	DCLK _RST-	GND	DNC	DDRPh	RCLK-	V_A	GND	GND_E	V_E	RSV6-	DQd0+	DQd1-	DQd3+	DQd4-	DQd6+	DQd7-	DQd8+	RSV4+	RSV5+	RSV5-	w
Y	GND	V_A	FSR	RCLK+	RCOut _1+	V_A	GND	V_E	GND_E	RSV6+	V_DR	DQd1+	GND_ DR	DQd4+	V_DR	DQd7+	GND_ DR	DQd9+	DQd9-	GND_ DR	Υ
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	

Figure 2. ADC10D1000/1500 Connection Diagram

#### **NOTE**

The center ground pins are for thermal dissipation and must be soldered to a ground plane to ensure rated performance. See SUPPLY/GROUNDING, LAYOUT AND THERMAL RECOMMENDATIONS for more information.

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### **Ball Descriptions and Equivalent Circuits**

Table 3. Analog Front-End and Clock Balls

Ball No.	Name	Equivalent Circuit	Description
H1/J1 N1/M1	Vinl+/- VinQ+/-	AGND VCMO Control from VCMO AGND AGND	Differential signal I- and Q-inputs. In the Non-Dual Edge Sampling (Non-DES) Mode, each I- and Q-input is sampled and converted by its respective channel with each positive transition of the CLK input. In Non-ECM (Non-Extended Control Mode) and DES Mode, both channels sample the I-input. In Extended Control Mode (ECM), the Q-input may optionally be selected for conversion in DES Mode by the DEQ Bit (Addr: 0h, Bit 6).  Each I- and Q-channel input has an internal common mode bias that is disabled when DC-coupled Mode is selected. Both inputs must be either AC- or DC-coupled. The coupling mode is selected by the V <sub>CMO</sub> Pin.  In Non-ECM, the full-scale range of these inputs is determined by the FSR Pin; both I- and Q-channels have the same full-scale input range. In ECM, the full-scale input range of the I- and Q-channel inputs may be independently set via the Control Register (Addr: 3h and Addr: Bh). Note that the high and low full-scale input range setting in Non-ECM corresponds to the mid and minimum full-scale input range in ECM.  The input offset may also be adjusted in ECM.
U2/V1	CLK+/-	AGND 50k VBIAS	Differential Converter Sampling Clock. In the Non-DES Mode, the analog inputs are sampled on the positive transitions of this clock signal. In the DES Mode, the selected input is sampled on both transitions of this clock. This clock must be AC-coupled.
V2/W1	DCLK_RST+/-	VA O AGND VA AGND	Differential DCLK Reset. A positive pulse on this input is used to reset the DCLKI and DCLKQ outputs of two or more ADC10D1000/1500s in order to synchronize them with other ADC10D1000/1500s in the system. DCLKI and DCLKQ are always in phase with each other, unless one channel is powered down, and do not require a pulse from DCLK_RST to become synchronized. The pulse applied here must meet timing relationships with respect to the CLK input. Although supported, this feature has been superseded by AutoSync.

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### Table 3. Analog Front-End and Clock Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
C2	V <sub>смо</sub>	V <sub>CMO</sub> V <sub>CMO</sub> V <sub>CMO</sub> Enable AC Coupling	Common Mode Voltage Output or Signal Coupling Select. If AC-coupled operation at the analog inputs is desired, this pin should be held at logic-low level. This pin is capable of sourcing/ sinking up to 100 $\mu\text{A}$ . For DC-coupled operation, this pin should be left floating or terminated into high-impedance. In DC-coupled Mode, this pin provides an output voltage which is the optimal common-mode voltage for the input signal and should be used to set the common-mode voltage of the driving buffer.
B1	$V_{BG}$	VA GND	Bandgap Voltage Output or LVDS Common-mode Voltage Select. This pin provides a buffered version of the bandgap output voltage and is capable of sourcing/sinking 100 uA and driving a load of up to 80 pF. Alternately, this pin may be used to select the LVDS digital output commonmode voltage. If tied to logic-high, the 1.2V LVDS common-mode voltage is selected; 0.8V is the default.
C3/D3	Rext+/-	VA GND	External Reference Resistor terminals. A 3.3 k $\Omega$ ±0.1% resistor should be connected between Rext+/ The Rext resistor is used as a reference to trim internal circuits which affect the linearity of the converter; the value and precision of this resistor should not be compromised.
C1/D2	Rtrim+/-	VA GND	Input Termination Trim Resistor terminals. A 3.3 k $\Omega$ ±0.1% resistor should be connected between Rtrim+/ The Rtrim resistor is used to establish the calibrated 100 $\Omega$ input impedance of VinI, VinQ and CLK. These impedances may be fine tuned by varying the value of the resistor by a corresponding percentage; however, the tuning range and performance is not specified for such an alternate value.
E2/F3	Tdiode+/-	Tdiode_P GND  VA  GND  VA  GND  VA  GND	Temperature Sensor Diode Positive (Anode) and Negative (Cathode) Terminals. This set of pins is used for die temperature measurements. It has not been fully characterized.

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### Table 3. Analog Front-End and Clock Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
Y4/W5	RCLK+/-	AGND 50k VBIAS	Reference Clock Input. When the AutoSync feature is active, and the ADC10D1000/1500 is in Slave Mode, the internal divided clocks are synchronized with respect to this input clock. The delay on this clock may be adjusted when synchronizing multiple ADCs. This feature is available in ECM via Control Register (Addr: Eh).
Y5/U6 V6/V7	RCOut1+/- RCOut2+/-	100Ω 100Ω 100Ω A GND	Reference Clock Output 1 and 2. These signals provide a reference clock at a rate of CLK/4, when enabled, independently of whether the ADC is in Master or Slave Mode. They are used to drive the RCLK of another ADC10D1000/1500, to enable automatic synchronization for multiple ADCs (AutoSync feature). The impedance of each trace from RCOut1 and RCOut2 to the RCLK of another ADC10D1000/1500 should be 100Ω differential. Having two clock outputs allows the autosynchronization to propagate as a binary tree. Use the DOC Bit (Addr: Eh, Bit 1) to enable/ disable this feature; default is disabled.

### **Table 4. Control and Status Balls**

Ball No.	Name	<b>Equivalent Circuit</b>	Description
V5	DES	V <sub>A</sub> GND	Dual Edge Sampling (DES) Mode select. In the Non-Extended Control Mode (Non-ECM), when this input is set to logic-high, the DES Mode of operation is selected, meaning that the VinI input is sampled by both channels in a time-interleaved manner. The VinQ input is ignored. When this input is set to logic-low, the device is in Non-DES Mode, i.e. the I- and Q-channels operate independently. In the Extended Control Mode (ECM), this input is ignored and DES Mode selection is controlled through the Control Register by the DES Bit (Addr: 0h, Bit 7); default is Non-DES Mode operation.
V4	CalDly	V <sub>A</sub> GND	Calibration Delay select. By setting this input logichigh or logic-low, the user can select the device to wait a longer or shorter amount of time, respectively, before the automatic power-on selfcalibration is initiated. This feature is pin-controlled only and is always active during ECM and Non-ECM.

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### Table 4. Control and Status Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
D6	CAL	VA GND	Calibration cycle initiate. The user can command the device to execute a self-calibration cycle by holding this input high a minimum of $t_{CAL\_H}$ after having held it low a minimum of $t_{CAL\_L}$ . If this input is held high at the time of power-on, the automatic power-on calibration cycle is inhibited until this input is cycled low-then-high. This pin is active in both ECM and Non-ECM. In ECM, this pin is logically OR'd with the CAL Bit (Addr: 0h, Bit 15) in the Control Register. Therefore, both pin and bit must be set low and then either can be set high to execute an on-command calibration.
B5	CalRun	VA GND	Calibration Running indication. This output is logic-high while the calibration sequence is executing. This output is logic-low otherwise.
U3 V3	PDI PDQ	VA 50 kΩ GND	Power Down I- and Q-channel. Setting either input to logic-high powers down the respective I- or Q-channel. Setting either input to logic-low brings the respective I- or Q-channel to a operational state after a finite time delay. This pin is active in both ECM and Non-ECM. In ECM, each Pin is logically OR'd with its respective Bit. Therefore, either this pin or the PDI and PDQ Bit in the Control Register can be used to power-down the I- and Q-channel (Addr: 0h, Bit 11 and Bit 10), respectively.
A4	ТРМ	VA GND	Test Pattern Mode select. With this input at logichigh, the device continuously outputs a fixed, repetitive test pattern at the digital outputs. In the ECM, this input is ignored and the Test Pattern Mode can only be activated through the Control Register by the TPM Bit (Addr: 0h, Bit 12).
A5	NDM	VA GND	Non-Demuxed Mode select. Setting this input to logic-high causes the digital output bus to be in the 1:1 Non-Demuxed Mode. Setting this input to logic-low causes the digital output bus to be in the 1:2 Demuxed Mode. This feature is pin-controlled only and remains active during ECM and Non-ECM.

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### Table 4. Control and Status Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
Y3	FSR	VA GND	Full-Scale input Range select. In Non-ECM, when this input is set to logic-low or logic-high, the full-scale differential input range for both I- and Q-channel inputs is set to the lower or higher FSR value, respectively. In the ECM, this input is ignored and the full-scale range of the I- and Q-channel inputs is independently determined by the setting of Addr: 3h and Addr: Bh, respectively. Note that the high (lower) FSR value in Non-ECM corresponds to the mid (min) available selection in ECM; the FSR range in ECM is greater.
W4	DDRPh	VA GND	DDR Phase select. This input, when logic-low, selects the 0° Data-to-DCLK phase relationship. When logic-high, it selects the 90° Data-to-DCLK phase relationship, i.e. the DCLK transition indicates the middle of the valid data outputs. This pin only has an effect when the chip is in 1:2 Demuxed Mode, i.e. the NDM pin is set to logic-low. In ECM, this input is ignored and the DDR phase is selected through the Control Register by the DPS Bit (Addr: 0h, Bit 14); the default is 0° Mode.
В3	ECE	VA 50 kΩ GND	Extended Control Enable bar. Extended feature control through the SPI interface is enabled when this signal is asserted (logic-low). In this case, most of the direct control pins have no effect. When this signal is de-asserted (logic-high), the SPI interface is disabled, all SPI registers are reset to their default values, and all available settings are controlled via the control pins.
C4	SCS	VA GND	Serial Chip Select bar. In ECM, when this signal is asserted (logic-low), SCLK is used to clock in serial data which is present on SDI and to source serial data on SDO. When this signal is deasserted (logic-high), SDI is ignored and SDO is in tri-stated.
C5	SCLK	VA GND	Serial Clock. In ECM, serial data is shifted into and out of the device synchronously to this clock signal. This clock may be disabled and held logic-low, as long as timing specifications are not violated when the clock is enabled or disabled.

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### Table 4. Control and Status Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
B4	SDI	VA 100 kg	Serial Data-In. In ECM, serial data is shifted into the device on this pin while SCS signal is asserted (logic-low).
АЗ	SDO	VA GND	Serial Data-Out. In ECM, serial data is shifted out of the device on this pin while SCS signal is asserted (logic-low). This output is tri-stated when SCS is de-asserted.
D1, D7, E3, F4, W3, U7	DNC	NONE	Do Not Connect. These pins are used for internal purposes and should not be connected, i.e. left floating. Do not ground.
C7	NC	NONE	Not Connected. This pin is not bonded and may be left floating or connected to any potential.

#### **Table 5. Power and Ground Balls**

Table 5. I owel and Ground Balls					
Ball No.	Name	Equivalent Circuit	Description		
A2, A6, B6, C6, D8, D9, E1, F1, H4, N4, R1, T1, U8, U9, W6, Y2, Y6	V <sub>A</sub>	NONE	Power Supply for the Analog circuitry. This supply is tied to the ESD ring. Therefore, it must be powered up before or with any other supply.		
G1, G3, G4, H2, J3, K3, L3, M3, N2, P1, P3, P4, R3, R4	V <sub>TC</sub>	NONE	Power Supply for the Track-and-Hold and Clock circuitry.		
A11, A15, C18, D11, D15, D17, J17, J20, R17, R20, T17, U11, U15, U16, Y11, Y15	$V_{DR}$	NONE	Power Supply for the Output Drivers.		
A8, B9, C8, V8, W9, Y8	V <sub>E</sub>	NONE	Power Supply for the Digital Encoder.		
J4, K2	VbiasI	NONE	Bias Voltage I-channel. This is an externally decoupled bias voltage for the I-channel. Each pin should individually be decoupled with a 100 nF capacitor via a low resistance, low inductance path to GND.		
L2, M4	VbiasQ	NONE	Bias Voltage Q-channel. This is an externally decoupled bias voltage for the Q-channel. Each pin should individually be decoupled with a 100 nF capacitor via a low resistance, low inductance path to GND.		

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10

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### Table 5. Power and Ground Balls (continued)

Ball No.	Name	Equivalent Circuit	Description
A1, A7, B2, B7, D4, D5, E4, K1, L1, T4, U4, U5, W2, W7, Y1, Y7, H8:N13	GND	NONE	Ground Return for the Analog circuitry.
F2, G2, H3, J2, K4, L4, M2, N3, P2, R2, T2, T3, U1	$GND_TC$	NONE	Ground Return for the Track-and-Hold and Clock circuitry.
A13, A17, A20, D13, D16, E17, F17, F20, M17, M20, U13, U17, V18, Y13, Y17, Y20	GND <sub>DR</sub>	NONE	Ground Return for the Output Drivers.
A9, B8, C9, V9, W8, Y9	GND <sub>E</sub>	NONE	Ground Return for the Digital Encoder.

### **Table 6. High-Speed Digital Outputs**

Ball No.	Name	Equivalent Circuit	Description
K19/K20 L19/L20	DCLKI+/- DCLKQ+/-	V <sub>DR</sub> DR GND	Data Clock Output for the I- and Q-channel data bus. These differential clock outputs are used to latch the output data and, if used, should always be terminated with a 100Ω differential resistor placed as closely as possible to the differential receiver. Delayed and non-delayed data outputs are supplied synchronously to this signal. In 1:2 Demux Mode or Non-Demux Mode, this signal is at ¼ or ½ the sampling clock rate, respectively. DCLKI and DCLKQ are always in phase with each other, unless one channel is powered down, and do not require a pulse from DCLK_RST to become synchronized.
K17/K18 L17/L18	ORI+/- ORQ+/-	DR GND	Out-of-Range Output for the I- and Q-channel. This differential output is asserted logic-high while the over- or under-range condition exists, i.e. the differential signal at each respective analog input exceeds the full-scale value. Each OR result refers to the current Data, with which it is clocked out. If used, each of these outputs should always be terminated with a $100\Omega$ differential resistor placed as closely as possible to the differential receiver.

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### **Table 6. High-Speed Digital Outputs (continued)**

Ball No.	Name	Equivalent Circuit	Description
J18/J19 H19/H20 H17/H18 G19/G20 G17/G18 F18/F19 E19/E20 D19/D20 D18/E18 C19/C20 . M18/M19 N19/N20 N17/N18 P19/P20 P17/P18 R18/R19 T19/T20 U18/T18 V19/V20	DI9+/- DI8+/- DI7+/- DI6+/- DI5+/- DI3+/- DI3+/- DI2+/- DI1+/- DI0+/	DR GND	I- and Q-channel Digital Data Outputs. In Non-Demux Mode, this LVDS data is transmitted at the sampling clock rate. In Demux Mode, these outputs provide ½ the data at ½ the sampling clock rate, synchronized with the delayed data, i.e. the other ½ of the data which was sampled one clock cycle earlier. Compared with the Dld and DQd outputs, these outputs represent the later time samples. If used, each of these outputs should always be terminated with a $100\Omega$ differential resistor placed as closely as possible to the differential receiver.
A18/A19 B17/C16 A16/B16 B15/C15 C14/D14 A14/B14 B13/C13 C12/D12 A12/B12 B11/C11 . Y18/Y19 W17/V16 Y16/W16 W15/V15 V14/U14 Y14/W14 W13/V13 V12/U12 Y12/W12 W11/V11	Did9+/- Did8+/- Did7+/- Did6+/- Did5+/- Did4+/- Did3+/- Did2+/- Did1+/- Did0+/ DQd9+/- DQd8+/- DQd5+/- DQd5+/- DQd3+/- DQd2+/- DQd2+/- DQd1+/- DQd1+/- DQd0+/-	V <sub>DR</sub> V <sub>DR</sub> V <sub>DR</sub> DR GND	Delayed I- and Q-channel Digital Data Outputs. In Non-Demux Mode, these outputs are tri-stated. In Demux Mode, these outputs provide $\frac{1}{2}$ the data at $\frac{1}{2}$ the sampling clock rate, synchronized with the non-delayed data, i.e. the other $\frac{1}{2}$ of the data which was sampled one clock cycle later. Compared with the DI and DQ outputs, these outputs represent the earlier time samples. If used, each of these outputs should always be terminated with a $100\Omega$ differential resistor placed as closely as possible to the differential receiver.
V10/U10 Y10/W10 W19/W20 W18/V17 B19/B20 B18/C17 C10/D10 A10/B10	RSV7+/- RSV6+/- RSV5+/- RSV4+/- RSV3+/- RSV2+/- RSV1+/- RSV0+/-	NONE	Reserved. These pins are used for internal purposes. They may be left unconnected and floating or connected as recommended in Terminating RSV Pins.

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12

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#### **Absolute Maximum Ratings**

See notes (1)(2)

Supply Voltage (V <sub>A</sub> , V <sub>TC</sub> , V <sub>DR</sub> , V <sub>E</sub> )	2.2V
Supply Difference max(V <sub>A/TC/DR/E</sub> )- min(V <sub>A/TC/DR/E</sub> )	0V to 100 mV
Voltage on Any Input Pin (except V <sub>IN</sub> +/-)	-0.15V to (V <sub>A</sub> + 0.15V)
V <sub>IN</sub> +/- Voltage Range	-0.15V to 2.5V
Ground Difference max(GND <sub>TC/DR/E</sub> ) -min(GND <sub>TC/DR/E</sub> )	0V to 100 mV
Input Current at Any Pin (3)	±50 mA
ADC10D1000 Package Power Dissipation at T <sub>A</sub> ≤ 85°C <sup>(3)</sup>	3.7 W
ADC10D1500 Package Power Dissipation at T <sub>A</sub> ≤ 70°C <sup>(3)</sup>	4.4 W
ESD Susceptibility <sup>(4)</sup> Human Body Model Charged Device Model Machine Model	2500V 750V 250V
Storage Temperature	−65°C to +150°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. There is no assurance of operation at the Absolute Maximum Ratings. For specifications and test conditions, see the Electrical Characteristics. The specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) All voltages are measured with respect to GND = GNDTC = GNDDR = GNDE = 0V, unless otherwise specified.
- (3) When the input voltage at any pin exceeds the power supply limits, i.e. less than GND or greater than V<sub>A</sub>, the current at that pin should be limited to 50 mA. In addition, over-voltage at a pin must adhere to the maximum voltage limits. Simultaneous over-voltage at multiple pins requires adherence to the maximum package power dissipation limits. These dissipation limits are calculated using JEDEC JESD51-7 thermal model. Higher dissipation may be possible based on specific customer thermal situation and specified package thermal resistances from junction to case.
- (4) Human body model is 100 pF capacitor discharged through a 1.5 kΩ resistor. Machine model is 220 pF discharged through 0Ω. Charged device model simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged.

### **Operating Ratings**

See notes (1)(2)

-40°C ≤ T <sub>A</sub> ≤ +85°C
-40°C ≤ T <sub>A</sub> ≤ +70°C
-40°C ≤ T <sub>A</sub> ≤ +85°C
T <sub>J</sub> ≤ +138°C
+1.8V to +2.0V
+1.8V to V <sub>A</sub>
0V to 2.15V (100% duty cycle) 0V to 2.5V (10% duty cycle)
0V
0V to V <sub>A</sub>
0.4V <sub>P-P</sub> to 2.0V <sub>P-P</sub>
V <sub>CMO</sub> - 150mV < V <sub>CMI</sub> < V <sub>CMO</sub> +150mV

<sup>(1)</sup> Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For specifications and test conditions, see the Electrical Characteristics. The specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

<sup>(2)</sup> All voltages are measured with respect to GND = GNDTC = GNDDR = GNDE = 0V, unless otherwise specified.

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#### **Package Thermal Resistance**

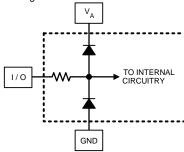
Package	θ <sub>JA</sub>	θ <sub>JC1</sub>	$\theta_{JC2}$
292-Ball BGA Thermally Enhanced Package	16°C/W	2.9°C/W	2.5°C/W

#### Converter Electrical Characteristics – Static Converter Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Comple al	Parameter	Conditions	ADC10D1000		ADC10D1500		Units
Symbol	Parameter	Conditions	Тур	Lim	Тур	Lim	(Limits)
	Resolution with No Missing Codes			10		10	bits
INL	Integral Non-Linearity (Best fit)	1 MHz DC-coupled over-ranged sine wave	±0.65	±1.4	±0.65	±1.4	LSB (max)
DNL	Differential Non-Linearity	1 MHz DC-coupled over-ranged sine wave	±0.25	±0.5	±0.25	±0.55	LSB (max)
V <sub>OFF</sub>	Offset Error		-2		-2		LSB
V <sub>OFF</sub> _ADJ	Input Offset Adjustment Range	Extended Control Mode	±45		±45		mV
PFSE	Positive Full-Scale Error	(5)		±25		±25	mV (max)
NFSE	Negative Full-Scale Error	(5)		±25		±25	mV (max)
	Out-of-Range Output Code (6)	$(V_{IN}+) - (V_{IN}-) > +$ Full Scale		1023		1023	
		(V <sub>IN</sub> +) - (V <sub>IN</sub> -) < - Full Scale		0		0	

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.
- (5) Calculation of Full-Scale Error for this device assumes that the actual reference voltage is exactly its nominal value. Full-Scale Error for this device, therefore, is a combination of Full-Scale Error and Reference Voltage Error. See Figure 4. For relationship between Gain Error and Full-Scale Error, see Specification Definitions for Gain Error.
- (6) This parameter is specified by design and is not tested in production.

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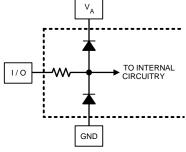
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### Converter Electrical Characteristics – Dynamic Converter Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

0	B	O Prince	ADC10	D1000	ADC1	ADC10D1500	
Symbol	Parameter	Conditions	Тур	Lim	Тур	Lim	(Limits)
FPBW	Full Power Bandwidth	Non-DES Mode	2.8		2.8		GHz
		DES Mode	1.25		1.25		GHz
		DESIQ Mode	1.75		1.75		GHz
	Gain Flatness	D.C. to Fs/2	±0.35		±0.4		dBFS
		D.C. to Fs	±0.5		±1.2		dBFS
CER	Code Error Rate		10 <sup>-18</sup>		10 <sup>-18</sup>		Error/Sam ple
NPR	Noise Power Ratio	f <sub>c,notch</sub> = 325 MHz, Notch width = 5%	48		48		dB
1:2 Demux No	on-DES Mode						
ENOB	Effective Number of Bits	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	9.1		9.0		bits
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	9.1	8.3	8.9		bits (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			8.8	7.8	bits (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	9.0	8.3			bits (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			8.8		bits
SINAD	Signal-to-Noise Plus Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	56.5		56.1		dB
	Ratio	A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	56.5	52	55.6		dB (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			54.9	48.4	dB (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	56	52			dB (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			54.5		dB
SNR	Signal-to-Noise Ratio	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	57		56.8		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	57	52.7	56.4		dB (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			56.4	50	dB (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	56.5	52.7			dB (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			55		dB

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.

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## ADC10D1000, ADC10D1500



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## Converter Electrical Characteristics – Dynamic Converter Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Symbol	Parameter	Conditions	ADC10	D1000	ADC1 Typ -65 -63 -60	0D1500	Units
Зуппрог	Farameter	Conditions	Тур	Lim	Тур	Lim	(Limits)
THD	Total Harmonic Distortion	$A_{IN}$ = 100 MHz @ -0.5 dBFS	-67		-65		dB
		$A_{IN}$ = 248 MHz @ -0.5 dBFS	-69	-60	-63		dB (max)
		$A_{IN}$ = 373 MHz @ -0.5 dBFS			-60	-53.6	dB (max)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-66	-60			dB (max)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-63		dB
2nd Harm	Second Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-76		-76		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-71		-71		dBc
		$A_{IN}$ = 373 MHz @ -0.5 dBFS			-71		dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-71				dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-70		dBc
3rd Harm	Third Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-70		-68		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-70		-72		dBc
		$A_{IN}$ = 373 MHz @ -0.5 dBFS			-63		dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-69				dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-65		dBc
SFDR	Spurious-Free Dynamic Range	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	70		68		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	66	57.9	68		dBc (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			63	54	dBc (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	66	57.9			dBc (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			65		dBc
Non-Demux N	lon-DES Mode <sup>(4)</sup>	•	•				
ENOB	Effective Number of Bits	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	9.1		9.1		bits
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	9.1	8.4	9.1		bits (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			8.8	7.8	bits (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	9.0	8.3	9.0		bits (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					bits
SINAD	Signal-to-Noise Plus Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	56.6		56.5		dB
	Ratio	A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	56.5	52.6	56.5		dB (min)
		$A_{IN}$ = 373 MHz @ -0.5 dBFS			54.5	48.4	dB (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	56	52.0	56		dB (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dB
SNR	Signal-to-Noise Ratio	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	57		57		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	57	53.5	57		dB (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			55.5	50	dB (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	56.5	52.7	56.5		dB (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dB
THD	Total Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-67		-67		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-66	-60	-66		dB (max)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			-60	-53.6	dB (max)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-66	-60	-66		dB (max)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dB

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### Converter Electrical Characteristics - Dynamic Converter Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Cumbal	Dovernator	Conditions	ADC10	D1000	ADC1	D1500	Units
Symbol	Parameter	Conditions	Тур	Lim	Тур	Lim	(Limits)
2nd Harm	Second Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-85		-85		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-71		-71		dBc
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS					dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-71		-71		dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dBc
3rd Harm	Third Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-68		-68		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-70		-70		dBc
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS					dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-70		-70		dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dBc
SFDR	Spurious-Free Dynamic Range	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	68		68		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	66	59	66		dBc (min)
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			63	54	dBc (min)
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	66	57.9	66		dBc (min)
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS					dBc
DES Mode (D	emux and Non-Demux Modes, Q-ir	put only)					
ENOB	Effective Number of Bits	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	8.6		8.9		bits
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	8.5		8.7		bits
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			8.5		bits
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	8.4				bits
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			8.3		bits
SINAD	Signal-to-Noise Plus Distortion Ratio	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	53.6		55.5		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	52.9		53.9		dB
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			52.7		dB
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	52.3				dB
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			51.7		dB
SNR	Signal-to-Noise Ratio	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	53.8		55.9		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	53.3		54.6		dB
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			53.8		dB
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	52.7				dB
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			52.1		dB
THD	Total Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-67		-66		dB
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-64		-62		dB
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			-59		dB
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-63				dB
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-62		dB
2nd Harm	Second Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-77		-80		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-66		-66		dBc
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			-64		dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-66				dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-70		dBc

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17



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## ADC10D1000, ADC10D1500



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### Converter Electrical Characteristics - Dynamic Converter Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Completel	Donomotor.	Conditions	ADC10	D1000	ADC10D1500		Units
Symbol	Parameter	Conditions	Тур	Lim	Тур	Lim	(Limits)
3rd Harm	Third Harmonic Distortion	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	-69		-67		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	-65		-70		dBc
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			-62		dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	-63				dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			-62		dBc
SFDR	Spurious-Free Dynamic Range	A <sub>IN</sub> = 100 MHz @ -0.5 dBFS	59.3		67		dBc
		A <sub>IN</sub> = 248 MHz @ -0.5 dBFS	58.9		62		dBc
		A <sub>IN</sub> = 373 MHz @ -0.5 dBFS			60		dBc
		A <sub>IN</sub> = 498 MHz @ -0.5 dBFS	57.4				dBc
		A <sub>IN</sub> = 748 MHz @ -0.5 dBFS			59		dBc

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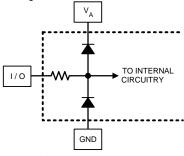
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### Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5 V<sub>P-P</sub> with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

0	Davamatar	Conditions	ADC10	D1000	ADC10D1500		Units
Symbol	Parameter		Тур	Lim	Тур	Lim	(Limits)
Analog Input	s			•		•	•
V <sub>IN_FSR</sub>	Analog Differential Input Full Scale	Non-Extended Control Mode					
	Range	FSR Pin Low	200	540	200	540	mV <sub>P-P</sub> (min)
			600	660	600	660	mV <sub>P-P</sub> (max)
		FSR Pin High	700	720	700	720	mV <sub>P-P</sub> (min)
			790	860	790	860	mV <sub>P-P</sub> (max)
		Extended Control Mode	*			!	
		FM(14:0) = 0000 <b>h</b>	600		600		$mV_{P-P}$
		FM(14:0) = 4000 <b>h</b> (default)	790		790		$mV_{P-P}$
		FM(14:0) = 7FFF <b>h</b>	980		980		$mV_{P-P}$
C <sub>IN</sub>	Analog Input Capacitance, Non-DES Mode <sup>(5)</sup> Analog Input Capacitance, DES Mode <sup>(5)</sup>	Differential	0.02		0.02		pF
		Each input pin to ground	1.6		1.6		pF
		Differential	0.08		0.08		pF
	DES Mode (5)	Each input pin to ground	2.2		2.2		pF
R <sub>IN</sub>	Differential Input Resistance		100	96	100	93	Ω (min)
			100	104	100	107	Ω (max)
Common Mo	de Output						
$V_{CMO}$	Common Mode Output Voltage	$I_{CMO} = \pm 100 \mu A$	1.05	1.15	4.05	1.15	V (min)
			1.25	1.35	1.25	1.35	V (max)
TC_V <sub>CMO</sub>	Common Mode Output Voltage Temperature Coefficient	I <sub>CMO</sub> = ±100 μA	38		38		ppm/°C
V <sub>CMO_LVL</sub>	V <sub>CMO</sub> input threshold to set DC-coupling Mode		0.63		0.63		V
C <sub>L</sub> _V <sub>CMO</sub>	Maximum V <sub>CMO</sub> Load Capacitance	(5)		80		80	pF

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.
- (5) This parameter is specified by design and is not tested in production.



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# Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Cumb al	Parameter Conditions	Canditions	ADC10D1000		ADC10D1500		Units
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
Bandgap Refe	rence						
$V_{BG}$	Bandgap Reference Output Voltage	I <sub>BG</sub> = ±100 μA	1.25	1.15	1.25	1.15	V (min)
				1.35	1.25	1.35	V (max)
TC_V <sub>BG</sub>	Bandgap Reference Voltage Temperature Coefficient	$I_{BG} = \pm 100 \mu A$	32		32		ppm/°C
C <sub>L</sub> _V <sub>BG</sub>	Maximum Bandgap Reference load Capacitance	(5)		80		80	pF

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## ADC10D1000, ADC10D1500

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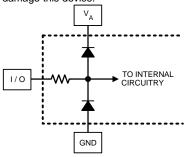
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#### Converter Electrical Characteristics – I-Channel to Q-Channel Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Cumbal	Parameter	Conditions	ADC10D1000		ADC10D1500		Units
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
	Offset Match		2		2		LSB
	Positive Full-Scale Match	Zero offset selected in Control Register	2		2		LSB
	Negative Full-Scale Match	Zero offset selected in Control Register	2		2		LSB
	Phase Matching (I, Q)	f <sub>IN</sub> = 1.0 GHz	< 1		< 1		Degree
X-TALK	Crosstalk from I-channel (Aggressor) to Q-channel (Victim)	Aggressor = 867 MHz F.S. Victim = 100 MHz F.S.	-70		-70		dB
	Crosstalk from Q-channel (Aggressor) to I-channel (Victim)	Aggressor = 867 MHz F.S. Victim = 100 MHz F.S.	-70		-70		dB

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.

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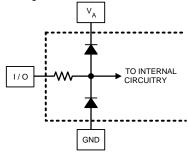
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### Converter Electrical Characteristics – Sampling Clock Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Cumbal	Parameter	Conditions	ADC10	ADC10D1000		D1500	Units
Symbol			Тур	Lim	Тур	Lim	(Limits)
V <sub>IN_CLK</sub>	Differential Sampling Clock Input	Sine Wave Clock	0.6	0.4	0.6	0.4	V <sub>P-P</sub> (min)
	Level (5)	Differential Peak-to-Peak	0.6	2.0	0.6	2.0	V <sub>P-P</sub> (max)
		Square Wave Clock	0.6	0.4	0.0	0.4	V <sub>P-P</sub> (min)
		Differential Peak-to-Peak	0.6	2.0	0.6	2.0	V <sub>P-P</sub> (max)
C <sub>IN_CLK</sub>	Sampling Clock Input Capacitance	Differential	0.1		0.1		pF
	(6)	Each input to ground	1		1		pF
R <sub>IN_CLK</sub>	Sampling Clock Differential Input Resistance		100		100		Ω

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.
- (5) This parameter is specified by design and/or characterization and is not tested in production.
- (6) This parameter is specified by design and is not tested in production.

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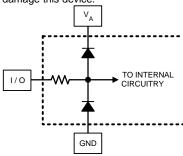
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### Converter Electrical Characteristics – Digital Control and Output Pin Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Comple at	Dozomotov	One Pittern	ADC1	0D1000	ADC10D1500		Units	
Symbol	Parameter	Conditions	Тур	Lim	Тур	Lim	(Limits)	
Digital Contro	ol Pins (DES, CalDly, CAL, PDI, PDG	, TPM, NDM, FSR, DDRPh, ECE, S	CLK, SD	ı, <del>SCS</del> )				
V <sub>IH</sub>	Logic High Input Voltage			0.7×V <sub>A</sub>		0.7×V <sub>A</sub>	V (min)	
V <sub>IL</sub>	Logic Low Input Voltage			0.3×V <sub>A</sub>		0.3×V <sub>A</sub>	V (max)	
I <sub>IH</sub>	Input Leakage Current; V <sub>IN</sub> = V <sub>A</sub>		0.02		0.02		μΑ	
I <sub>IL</sub>	Input Leakage Current; V <sub>IN</sub> = GND	FSR, CalDly, CAL, NDM, TPM, DDRPh, DES	-0.02		-0.02		μΑ	
		SCS, SCLK, SDI	-17		-17		μΑ	
		PDI, PDQ, ECE	-38		-38		μΑ	
C <sub>IN_DIG</sub>	Digital Control Pin Input Capacitance	Measured from each control pin to GND	1.5		1.5		pF	
Digital Outpu	t Pins (Data, DCLKI, DCLKQ, ORI, C	DRQ)						
V <sub>OD</sub>	LVDS Differential Output Voltage	V <sub>BG</sub> = Floating, OVS = High	560	375	500	375	mV <sub>P-P</sub> (min)	
				750	560	750	mV <sub>P-P</sub> (max)	
		V <sub>BG</sub> = Floating, OVS = Low	400	260	400	260	mV <sub>P-P</sub> (min)	
			400	560	400	560	mV <sub>P-P</sub> (max)	
		$V_{BG} = V_A$ , OVS = High	600		600		$mV_{P-P}$	
		V <sub>BG</sub> = V <sub>A</sub> , OVS = Low	440		440		$mV_{P-P}$	
$\Delta V_{O\ DIFF}$	Change in LVDS Output Swing Between Logic Levels		±1		±1		mV	
Vos	Output Offset Voltage	V <sub>BG</sub> = Floating	0.8		0.8		V	
		$V_{BG} = V_A$	1.2		1.2		V	
$\Delta V_{OS}$	Output Offset Voltage Change Between Logic Levels		±1		±1		mV	

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.
- (5) This parameter is specified by design and is not tested in production.



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# Converter Electrical Characteristics – Digital Control and Output Pin Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Symbol	Parameter	Conditions	ADC10	ADC10D1000		ADC10D1500	
		Conditions	Тур	Lim	Тур	Lim	(Limits)
I <sub>OS</sub>	Output Short Circuit Current	V <sub>BG</sub> = Floating; D+ and D- connected to 0.8V	±4		±4		mA
Z <sub>O</sub>	Differential Output Impedance		100		100		Ω
V <sub>OH</sub>	Logic High Output Level	CalRun, SDO I <sub>OH</sub> = −400 µA <sup>(6)</sup>	1.65	1.5	1.65	1.5	V
V <sub>OL</sub>	Logic Low Output Level	CalRun, SDO I <sub>OL</sub> = 400 μA <sup>(6)</sup>	0.15	0.3	0.15	0.3	V
Differential DO	CLK Reset Pins (DCLK_RST)						
V <sub>CMI_DRST</sub>	DCLK_RST Common Mode Input Voltage		1.25±0. 15		1.25±0. 15		V
V <sub>ID_DRST</sub>	Differential DCLK_RST Input Voltage		V <sub>IN_CLK</sub>		V <sub>IN_CLK</sub>		V <sub>P-P</sub>
R <sub>IN_DRST</sub>	Differential DCLK_RST Input Resistance	(5)	100		100		Ω

<sup>(6)</sup> This parameter is specified by design and/or characterization and is not tested in production.

24

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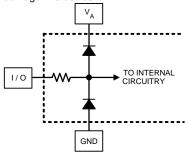
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### Converter Electrical Characteristics - Power Supply Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Comple ed	Parameter	Conditions	ADC10	D1000	ADC10	D1500	Units
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
I <sub>A</sub>	Analog Supply Current	1:2 Demux Mode					•
		PDI = PDQ = Low	895	985	1170		mA (max)
		PDI = Low; PDQ = High	510		645		mA
		PDI = High; PDQ = Low	510		645		mA
		PDI = PDQ = High	2		2		mA
		Non-Demux Mode (4)					
		PDI = PDQ = Low	895	985	1095		mA (max)
		PDI = Low; PDQ = High	510		600		mA
		PDI = High; PDQ = Low	510		600		mA
		PDI = PDQ = High	2		2		mA
I <sub>TC</sub>	Track-and-Hold and Clock Supply	1:2 Demux Mode					
	Current	PDI = PDQ = Low	360	400	425		mA (max)
		PDI = Low; PDQ = High	220		260		mA
		PDI = High; PDQ = Low	220		260		mA
		PDI = PDQ = High	1		1.5		mA
		Non-Demux Mode (4)					
		PDI = PDQ = Low	360	400	370		mA (max)
		PDI = Low; PDQ = High	220		225		mA
		PDI = High; PDQ = Low	220		225		mA
		PDI = PDQ = High	1		1.5		mA

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.

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## ADC10D1000, ADC10D1500



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## **Converter Electrical Characteristics – Power Supply Characteristics (continued)**

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Symbol	Parameter	Conditions	ADC10	D1000	ADC10	0D1500	Units
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
I <sub>DR</sub>	Output Driver Supply Current	1:2 Demux Mode		•	•	•	·
		PDI = PDQ = Low	210	260	220		mA (max)
		PDI = Low; PDQ = High	115		120		mA
		PDI = High; PDQ = Low	115		120		mA
		PDI = PDQ = High	10		15		μA
		Non-Demux Mode (4)					
		PDI = PDQ = Low	135	170	125		mA (max)
		PDI = Low; PDQ = High	80		75		mA
		PDI = High; PDQ = Low	80		75		mA
		PDI = PDQ = High	10		15		μA
IE	Digital Encoder Supply Current	1:2 Demux Mode					
		PDI = PDQ = Low	60	100	100		mA (max)
		PDI = Low; PDQ = High	35		50		mA
		PDI = High; PDQ = Low	35		50		mA
		PDI = PDQ = High	10		70		μA
		Non-Demux Mode (4)					
		PDI = PDQ = Low	68	100	65		mA (max)
		PDI = Low; PDQ = High	40		40		mA
		PDI = High; PDQ = Low	40		40		mA
		PDI = PDQ = High	10		70		μA
I <sub>TOTAL</sub>	Total Supply Current	1:2 Demux Mode PDI = PDQ = Low	1525	1745	1915	2092	mA (max)
$P_{C}$	Power Consumption	1:2 Demux Mode					
		PDI = PDQ = Low	2.90	3.31	3.64	3.98	W (max)
		PDI = Low; PDQ = High	1.66		2.00		W
		PDI = High; PDQ = Low	1.66		2.00		W
		PDI = PDQ = High	6		7		mW
		Non-Demux Mode (4)	·				
		PDI = PDQ = Low	2.77	3.14	3.14		W (max)
		PDI = Low; PDQ = High	1.61		1.68		W
		PDI = High; PDQ = Low	1.61		1.68		W
		PDI = PDQ = High	6		7		mW

Product Folder Links: ADC10D1000, ADC10D1500

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## ADC10D1000, ADC10D1500

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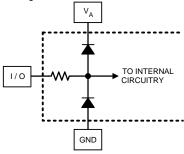
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### Converter Electrical Characteristics - AC Electrical Characteristics

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5 V<sub>P-P</sub> with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Ob. a.l	Parameter	Conditions	ADC10	ADC10D1000		ADC10D1500	
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
Sampling Clo	ock (CLK)	ı	•				•
f <sub>CLK (max)</sub>	Maximum Sampling Clock Frequency			1.0		1.5	GHz (min)
f <sub>CLK (min)</sub>	Minimum Sampling Clock	Non-DES Mode	200		200		MHz
	Frequency	DES Mode	250		250		MHz
	Sampling Clock Duty Cycle	$f_{CLK(min)} \le f_{CLK} \le f_{CLK(max)}$	50	20	50	20	% (min)
		(5)	50	80	50	80	% (max)
t <sub>CL</sub>	Sampling Clock Low Time	(6)	500	200	333	133	ps (min)
t <sub>CH</sub>	Sampling Clock High Time	(6)	500	200	333	133	ps (min)
Data Clock (I	OCLKI, DCLKQ)	ı	•				•
	DCLK Duty Cycle	(6)		45		45	% (min)
			50	55	50	55	% (max)
t <sub>SR</sub>	Setup Time DCLK_RST±	(5)	45		45		ps
t <sub>HR</sub>	Hold Time DCLK_RST±	(5)	45		45		ps
t <sub>PWR</sub>	Pulse Width DCLK_RST±	(6)		5		5	Sampling Clock Cycles (min)
t <sub>SYNC DLY</sub>	DCLK Synchronization Delay	90° Mode (6)		4		4	Sampling
		0° Mode <sup>(6)</sup>		5		5	Clock Cycles
t <sub>LHT</sub>	Differential Low-to-High Transition Time	10%-to-90%, C <sub>L</sub> = 2.5 pF	220		220		ps
t <sub>HLT</sub>	Differential High-to-Low Transition Time	10%-to-90%, C <sub>L</sub> = 2.5 pF	220		220		ps
t <sub>SU</sub>	Data-to-DCLK Setup Time	90° Mode <sup>(6)</sup>	850		545		ps
t <sub>H</sub>	DCLK-to-Data Hold Time	90° Mode <sup>(6)</sup>	850		570		ps

(1) The analog inputs, labeled "I/O", are protected as shown below. Input voltage magnitudes beyond the Absolute Maximum Ratings may damage this device.



- (2) To specify accuracy, it is required that V<sub>A</sub>, V<sub>TC</sub>, V<sub>E</sub> and V<sub>DR</sub> be well-bypassed. Each supply pin must be decoupled with separate bypass capacitors.
- (3) Typical figures are at T<sub>A</sub> = 25°C, and represent most likely parametric norms. Test limits are specified to AOQL (Average Outgoing Quality Level).
- (4) The maximum clock frequency for Non-Demux Mode is tested up to 1.0 GHz for both the ADC10D1000 and the ADC10D1500 and specified by design and characterization up to 1.5 GHz for the ADC10D1500.
- (5) This parameter is specified by design and/or characterization and is not tested in production.
- (6) This parameter is specified by design and is not tested in production.

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## ADC10D1000, ADC10D1500



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### Converter Electrical Characteristics – AC Electrical Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High;  $C_L = 10$  pF; Differential, AC coupled Sine Wave Sampling Clock,  $f_{CLK} = 1.0/1.5$  GHz at 0.5  $V_{P-P}$  with 50% duty cycle (as specified);  $V_{BG} = Floating$ ; Non-Extended Control Mode; Rext = Rtrim =  $3300\Omega \pm 0.1\%$ ; Analog Signal Source Impedance =  $100\Omega$  Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. **Boldface limits apply for T**<sub>A</sub> = **T**<sub>MIN</sub> **to T**<sub>MAX</sub>. All other limits T<sub>A</sub> =  $25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

Cumbel	Parameter		ADC1	0D1000	ADC10D1500		Units
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
t <sub>OSK</sub>	DCLK-to-Data Output Skew	50% of DCLK transition to 50% of Data transition <sup>(6)</sup>	±50		±50		ps (max)
Data Input-to	-Output						
$t_{AD}$	Aperture Delay	Sampling CLK+ Rise to Acquisition of Data	1.1		1.1		ns
t <sub>AJ</sub>	Aperture Jitter		0.2		0.2		ps (rms)
t <sub>OD</sub>	Sampling Clock-to Data Output Delay (in addition to Latency)	50% of Sampling Clock transition to 50% of Data transition	2.4		2.4		ns
t <sub>LAT</sub>	Latency in 1:2 Demux Non-DES	DI, DQ Outputs		34		34	
	Mode <sup>(6)</sup>	Dld, DQd Outputs		35		35	
	Latency in 1:4 Demux DES Mode	DI Outputs		34		34	
	(6)	DQ Outputs		34.5		34.5	
		Dld Outputs		35		35	Sampling Clock
		DQd Outputs		35.5		35.5	Cycles
	Latency in Non-Demux Non-DES Mode <sup>(6)</sup>	DI Outputs		34		34	
		DQ Outputs		34		34	
	Latency in Non-Demux DES Mode (6)	DI Outputs		34		34	
		DQ Outputs		34.5		34.5	
t <sub>ORR</sub>	Over Range Recovery Time	Differential V <sub>IN</sub> step from ±1.2V to 0V to accurate conversion	1		1		Sampling Clock Cycle
t <sub>WU</sub>	Wake-Up Time (PDI/PDQ low to	Non-DES Mode (6)	500		500		ns
	Rated Accuracy Conversion)	DES Mode <sup>(6)</sup>	1		1		μs
Serial Port In	terface						
f <sub>SCLK</sub>	Serial Clock Frequency	(6)	15		15		MHz
	Serial Clock Low Time			30		30	ns (min)
	Serial Clock High Time			30		30	ns (min)
t <sub>SSU</sub>	Serial Data-to-Serial Clock Rising Setup Time	(6)	2.5		2.5		ns (min)
t <sub>SH</sub>	Serial Data-to-Serial Clock Rising Hold Time	(7)	1		1		ns (min)
t <sub>SCS</sub>	SCS-to-Serial Clock Rising Setup Time		2.5		2.5		ns
t <sub>HCS</sub>	SCS-to-Serial Clock Falling Hold Time		1.5		1.5		ns
t <sub>BSU</sub>	Bus turn-around time		10		10		ns

<sup>(7)</sup> This parameter is specified by design and is not tested in production.

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### Converter Electrical Characteristics – AC Electrical Characteristics (continued)

The following specifications apply after calibration for  $V_A = V_{DR} = V_{TC} = V_E = +1.9V$ ; I- and Q-channels, AC-coupled, unused channel terminated to AC ground, FSR Pin = High; C<sub>L</sub> = 10 pF; Differential, AC coupled Sine Wave Sampling Clock, f<sub>CLK</sub> = 1.0/1.5 GHz at 0.5 V<sub>P-P</sub> with 50% duty cycle (as specified); V<sub>BG</sub> = Floating; Non-Extended Control Mode; Rext = Rtrim = 3300Ω ± 0.1%; Analog Signal Source Impedance = 100Ω Differential; 1:2 Demultiplex Non-DES Mode; Duty Cycle Stabilizer on. Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$ . All other limits  $T_A = 25^{\circ}$ C, unless otherwise noted. (1) (2) (3) (4)

0	Parameter	O and Pathons	ADC10	ADC10D1000		ADC10D1500	
Symbol		Conditions	Тур	Lim	Тур	Lim	(Limits)
Calibration							
t <sub>CAL</sub>	Calibration Cycle Time	Non-ECM	2.4·10 <sup>7</sup>		2.4·10 <sup>7</sup>		Sampling
		ECM CSS = 0 <b>b</b>	2.3·10 <sup>7</sup>		2.3·10 <sup>7</sup>		Clock Cycles
		ECM; CSS = 1 <b>b</b>					
		CMS(1:0) = 00 <b>b</b>	0.8·10 <sup>7</sup>		0.8·10 <sup>7</sup>		Sampling
		CMS(1:0) = 01 <b>b</b>	1.5·10 <sup>7</sup>		1.5·10 <sup>7</sup>		Clock
		CMS(1:0) = 10 <b>b</b> (ECM default)	2.4·10 <sup>7</sup>		2.4·10 <sup>7</sup>		Cycles
t <sub>CAL_L</sub>	CAL Pin Low Time	(8)		1280		1280	Clock Cycles (min)
t <sub>CAL_H</sub>	CAL Pin High Time	(8)		1280		1280	Clock Cycles (min)
	Calibration delay determined by	CalDly = Low		<b>2</b> <sup>24</sup>		<b>2</b> <sup>24</sup>	Clock
t <sub>CalDly</sub>	CalDly Pin (8)	CalDly = High		2 <sup>30</sup>		2 <sup>30</sup>	Cycles (max)

<sup>(8)</sup> This parameter is specified by design and is not tested in production.

### **Specification Definitions**

APERTURE (SAMPLING) DELAY is the amount of delay, measured from the sampling edge of the CLK input, after which the signal present at the input pin is sampled inside the device.

APERTURE JITTER (tAJ) is the variation in aperture delay from sample-to-sample. Aperture jitter can be effectively considered as noise at the input.

CODE ERROR RATE (CER) is the probability of error and is defined as the probable number of word errors on the ADC output per unit of time divided by the number of words seen in that amount of time. A CER of 10<sup>-18</sup> corresponds to a statistical error in one word about every 31.7 years.

CLOCK DUTY CYCLE is the ratio of the time that the clock waveform is at a logic high to the total time of one clock period.

DIFFERENTIAL NON-LINEARITY (DNL) is the measure of the maximum deviation from the ideal step size of 1 LSB. It is measured at the relevant sample rate,  $f_{CLK}$ , with  $f_{IN} = 1$ MHz sine wave.

EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS) is another method of specifying Signal-to-Noise and Distortion Ratio, or SINAD. ENOB is defined as (SINAD - 1.76) / 6.02 and states that the converter is equivalent to a perfect ADC of this many (ENOB) number of bits.

FULL POWER BANDWIDTH (FPBW) is a measure of the frequency at which the reconstructed output fundamental drops to 3 dB below its low frequency value for a full-scale input.

GAIN ERROR is the deviation from the ideal slope of the transfer function. It can be calculated from Offset and Full-Scale Errors. The Positive Gain Error is the Offset Error minus the Positive Full-Scale Error. The Negative Gain Error is the Negative Full-Scale Error minus the Offset Error. The Gain Error is the Negative Full-Scale Error minus the Positive Full-Scale Error; it is also equal to the Positive Gain Error plus the Negative Gain Error.

INTEGRAL NON-LINEARITY (INL) is a measure of worst case deviation of the ADC transfer function from an ideal straight line drawn through the ADC transfer function. The deviation of any given code from this straight line is measured from the center of that code value step. The best fit method is used.

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### ADC10D1000, ADC10D1500



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**LSB (LEAST SIGNIFICANT BIT)** is the bit that has the smallest value or weight of all bits. This value is  $V_{FS}/2^N$  (1)

where  $V_{FS}$  is the differential full-scale amplitude  $V_{IN\_FSR}$  as set by the FSR input and "N" is the ADC resolution in bits, which is 10 for the ADC10D1000/1500.

**LOW VOLTAGE DIFFERENTIAL SIGNALING (LVDS) DIFFERENTIAL OUTPUT VOLTAGE (V**<sub>ID</sub> and V<sub>OD</sub>) is two times the absolute value of the difference between the V<sub>D</sub>+ and V<sub>D</sub>- signals; each signal measured with respect to Ground. V<sub>OD</sub> peak is V<sub>OD,P</sub>= (V<sub>D</sub>+ - V<sub>D</sub>-) and V<sub>OD</sub> peak-to-peak is V<sub>OD,P-P</sub>=  $2*(V_D+ - V_D-)$ ; for this product, the V<sub>OD</sub> is measured peak-to-peak.

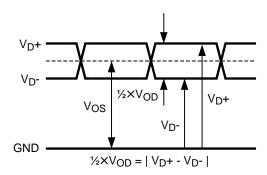


Figure 3. LVDS Output Signal Levels

**LVDS OUTPUT OFFSET VOLTAGE (V\_{OS})** is the midpoint between the D+ and D- pins output voltage with respect to ground; i.e.,  $[(V_D+) + (V_D-)]/2$ . See Figure 3.

MISSING CODES are those output codes that are skipped and will never appear at the ADC outputs. These codes cannot be reached with any input value.

MSB (MOST SIGNIFICANT BIT) is the bit that has the largest value or weight. Its value is one half of full scale.

**NEGATIVE FULL-SCALE ERROR (NFSE)** is a measure of how far the first code transition is from the ideal 1/2 LSB above a differential  $-V_{IN}/2$  with the FSR pin low. For the ADC10D1000/1500 the reference voltage is assumed to be ideal, so this error is a combination of full-scale error and reference voltage error.

**NOISE POWER RATIO (NPR)** is the ratio of the sum of the power inside the notched bins to the sum of the power in an equal number of bins outside the notch, expressed in dB. NPR is similar to, but more complete than intermodulation distortion measurements.

**OFFSET ERROR (V<sub>OFF</sub>)** is a measure of how far the mid-scale point is from the ideal zero voltage differential input.

Offset Error = Actual Input causing average of 8k samples to result in an average code of 511.5.

**OUTPUT DELAY (top)** is the time delay (in addition to Latency) after the rising edge of CLK+ before the data update is present at the output pins.

**OVER-RANGE RECOVERY TIME** is the time required after the differential input voltages goes from ±1.2V to 0V for the converter to recover and make a conversion with its rated accuracy.

**PIPELINE DELAY (LATENCY)** is the number of input clock cycles between initiation of conversion and when that data is presented to the output driver stage. The data lags the conversion by the Latency plus the t<sub>OD</sub>.

**POSITIVE FULL-SCALE ERROR (PFSE)** is a measure of how far the last code transition is from the ideal 1-1/2 LSB below a differential  $+V_{IN}/2$ . For the ADC10D1000/1500 the reference voltage is assumed to be ideal, so this error is a combination of full-scale error and reference voltage error.

**SIGNAL TO NOISE RATIO (SNR)** is the ratio, expressed in dB, of the rms value of the fundamental for a singletone to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or DC.

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**SIGNAL TO NOISE PLUS DISTORTION (S/(N+D) or SINAD)** is the ratio, expressed in dB, of the rms value of the fundamental for a single-tone to the rms value of all of the other spectral components below half the input clock frequency, including harmonics but excluding DC.

**SPURIOUS-FREE DYNAMIC RANGE (SFDR)** is the difference, expressed in dB, between the rms values of the input signal at the output and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input, excluding DC.

 $\theta_{JA}$  is the thermal resistance between the junction to ambient.

 $\theta_{JC1}$  represents the thermal resistance between the die and the exposed metal area on the top of the HSBGA package.

 $\theta_{JC2}$  represents the thermal resistance between the die and the center group of balls on the bottom of the HSBGA package.

**TOTAL HARMONIC DISTORTION (THD)** is the ratio expressed in dB, of the rms total of the first nine harmonic levels at the output to the level of the fundamental at the output. THD is calculated as

THD = 20 x log 
$$\sqrt{\frac{A_{f2}^2 + \dots + A_{f10}^2}{A_{f1}^2}}$$

(2)

where  $A_{f1}$  is the RMS power of the fundamental (output) frequency and  $A_{f2}$  through  $A_{f10}$  are the RMS power of the first 9 harmonic frequencies in the output spectrum.

- Second Harmonic Distortion (2nd Harm) is the difference, expressed in dB, between the RMS power in the input frequency seen at the output and the power in its 2nd harmonic level at the output.
- Third Harmonic Distortion (3rd Harm) is the difference expressed in dB between the RMS power in the input frequency seen at the output and the power in its 3rd harmonic level at the output.



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#### **Transfer Characteristic**

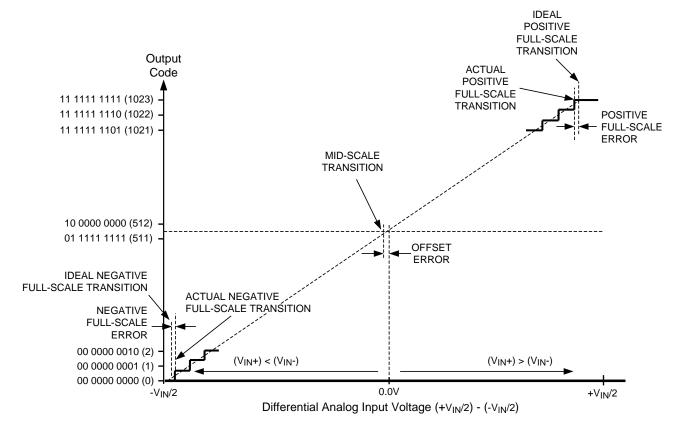


Figure 4. Input / Output Transfer Characteristic

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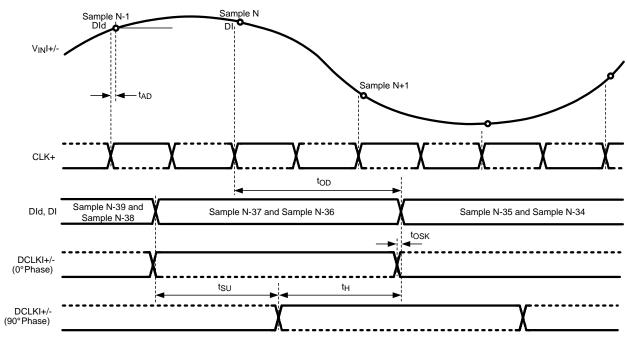
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### **TEST CIRCUIT DIAGRAMS**

#### **Timing Diagrams**



<sup>\*</sup> Note: The timing for Figure 5 - Figure 8 is shown for the one input only (I or Q). However, both I- and Q-inputs may be used. For this case, the I-channel functions precisely the same as the Q-channel, with VinI, DCLKI, DId and DI instead of VinQ, DCLKQ, DQd and DQ. Both I- and Q-channel use the same CLK.

Figure 5. Clocking in 1:2 Demux Non-DES Mode\*

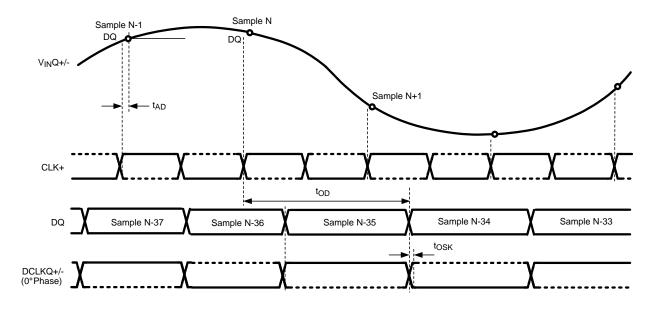


Figure 6. Clocking in Non-Demux Non-DES Mode (See note at Figure 5)



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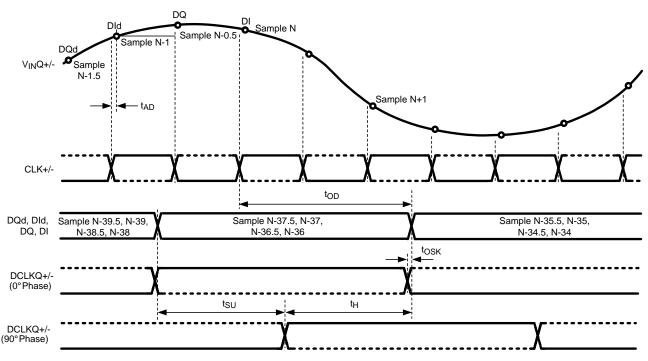


Figure 7. Clocking in 1:4 Demux DES Mode (See note at Figure 5)

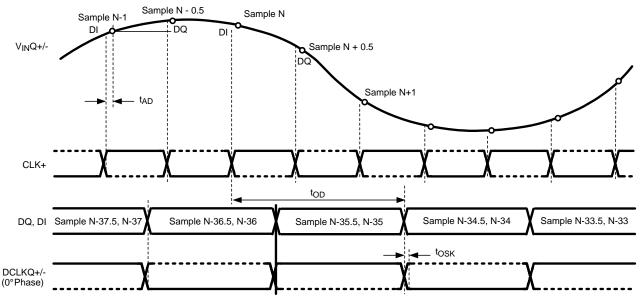


Figure 8. Clocking in Non-Demux Mode DES Mode (See note at Figure 5)



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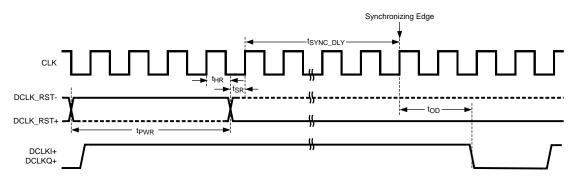


Figure 9. Data Clock Reset Timing (Demux Mode)

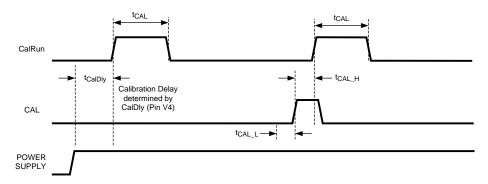


Figure 10. Power-on and On-Command Calibration Timing

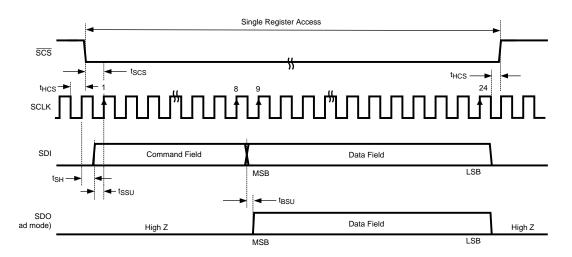


Figure 11. Serial Interface Timing

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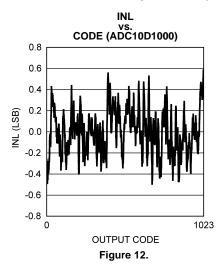


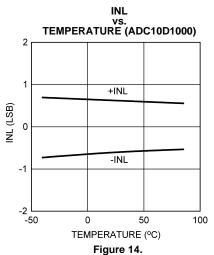
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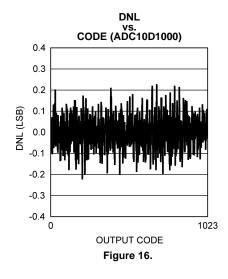
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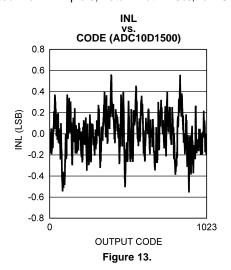
#### **Typical Performance Plots**

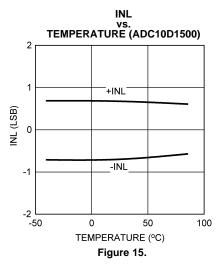
 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25$ °C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

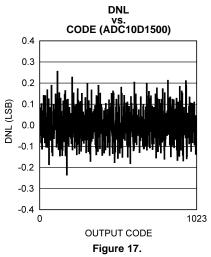












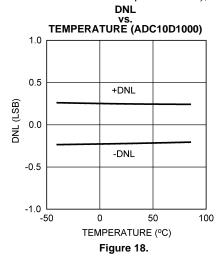


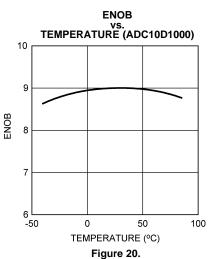
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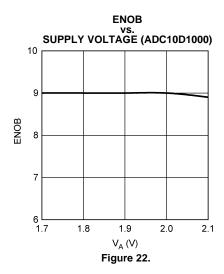
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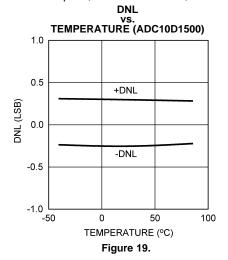
### **Typical Performance Plots (continued)**

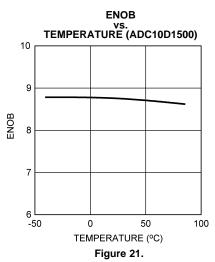
 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25^{\circ}$ C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

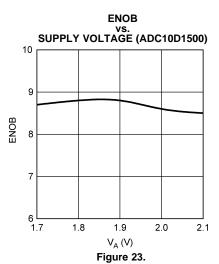












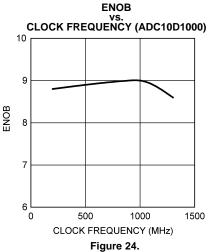


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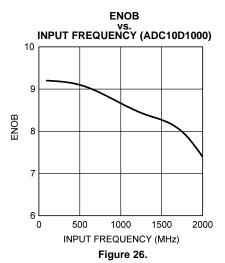
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#### **Typical Performance Plots (continued)**

 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25$ °C, I-channel, 1:2 Demux Non-DES Mode (1:1) Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.







8

1200

**ENOB** 

vs. V<sub>CMI</sub> (ADC10D1000)

 $V_{CMI}$  (mV) Figure 28.

1300

1400

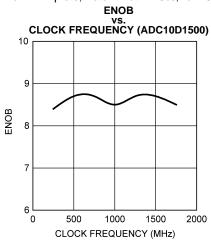


Figure 25.

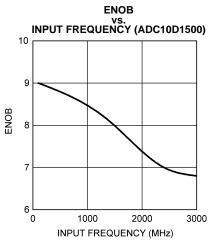
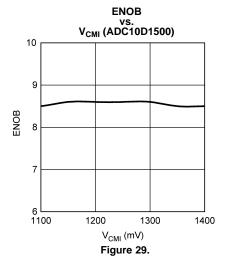


Figure 27.



1100

10

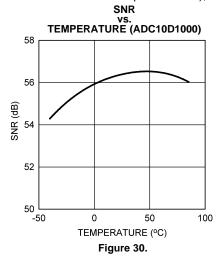


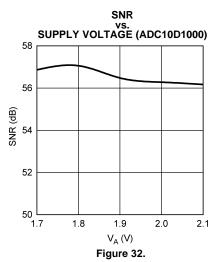
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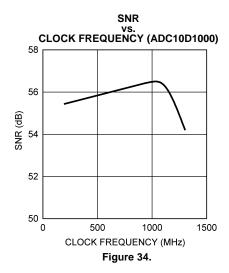
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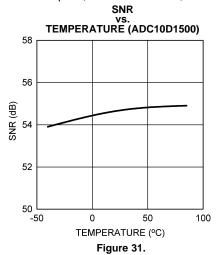
### **Typical Performance Plots (continued)**

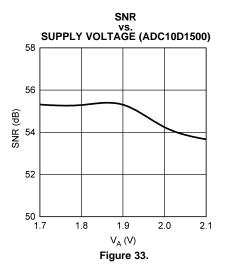
 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25^{\circ}$ C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

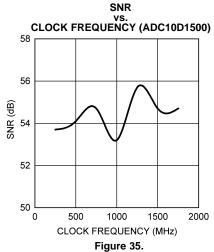












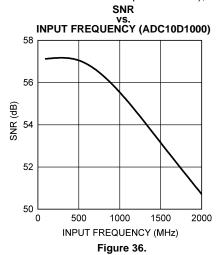


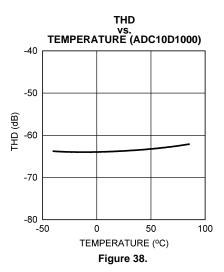
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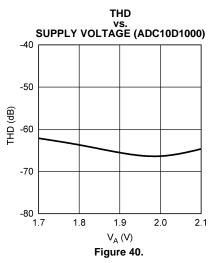
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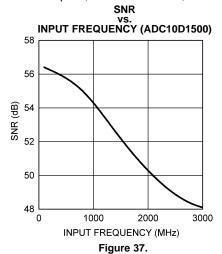
#### **Typical Performance Plots (continued)**

 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25^{\circ}$ C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

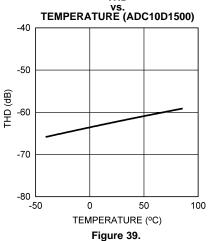




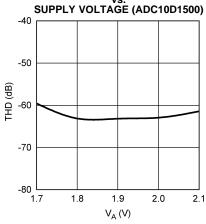








THD vs.
SUPPLY VOLTAGE (ADC10D1500)



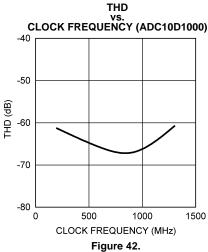


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### **Typical Performance Plots (continued)**

 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25$ °C, I-channel, 1:2 Demux Non-DES Mode (1:1) Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.





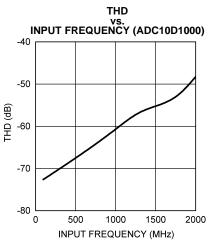
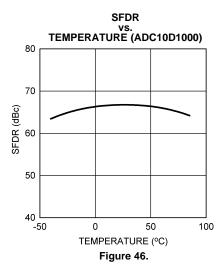
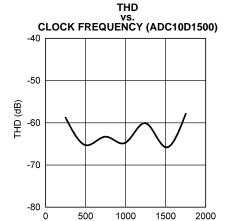


Figure 44.





CLOCK FREQUENCY (MHz) Figure 43.

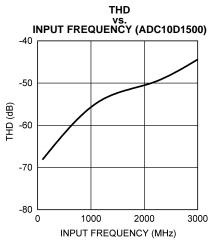
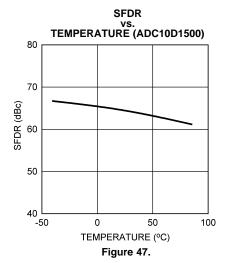


Figure 45.



# electronic components

### ADC10D1000, ADC10D1500

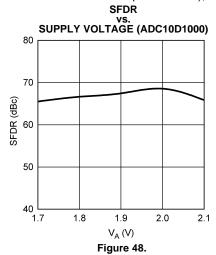


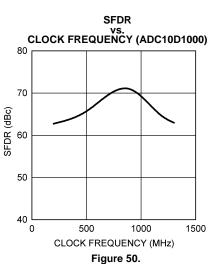
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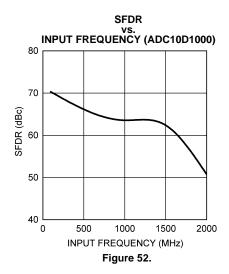
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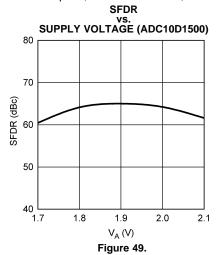
#### **Typical Performance Plots (continued)**

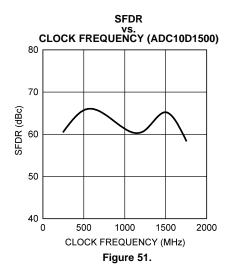
 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25^{\circ}$ C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

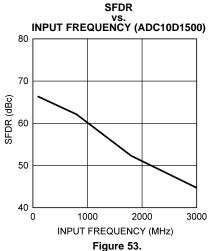












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#### **Typical Performance Plots (continued)**

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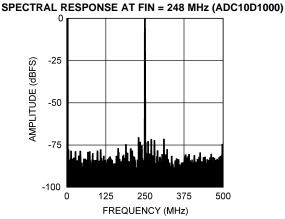


Figure 54.

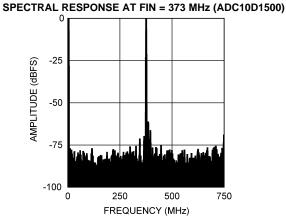


Figure 55.

#### SPECTRAL RESPONSE AT FIN = 498 MHz (ADC10D1000)

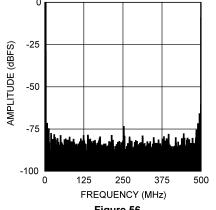
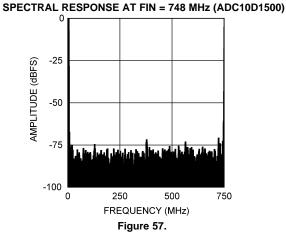
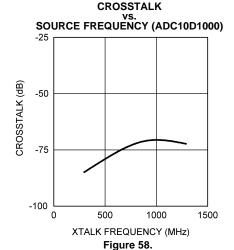


Figure 56.



**CROSSTALK** 



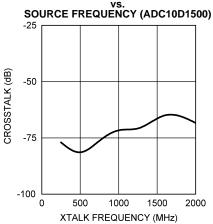


Figure 59.



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#### **Typical Performance Plots (continued)**

 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25^{\circ}$ C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.

#### **FULL POWER BANDWIDTH (ADC10D1000)**

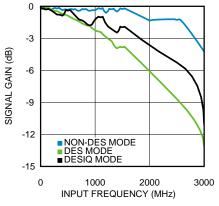


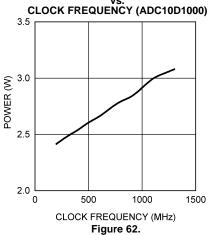
Figure 60.

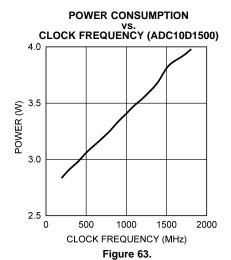
FULL POWER BANDWIDTH (ADC10D1500)

0
-3
-3
-12
-12
-15
0 1000 2000 3000
INPUT FREQUENCY (MHz)

Figure 61.

### POWER CONSUMPTION vs.





VS.
RMS NOISE LOADING LEVEL (ADC10D1000)

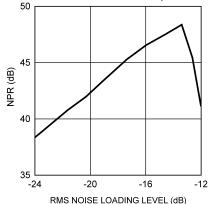


Figure 64.

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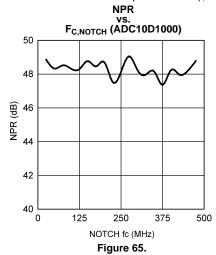
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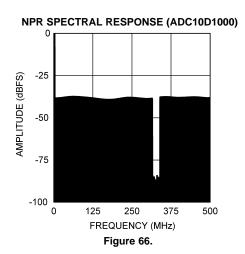
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#### **Typical Performance Plots (continued)**

 $V_A = V_{DR} = V_{TC} = V_E = 1.9V$ ,  $f_{CLK} = 1.0/1.5$  GHz,  $f_{IN} = 498/748$  MHz,  $T_A = 25$ °C, I-channel, 1:2 Demux Non-DES Mode (1:1 Demux Non-DES Mode has similar performance), unless otherwise stated. For NPR plots, notch width = 5%, fc = 325 MHz.





#### **Functional Description**

The ADC10D1000/1500 is a versatile A/D converter with an innovative architecture which permits very high speed operation. The controls available ease the application of the device to circuit solutions. Optimum performance requires adherence to the provisions discussed here and in the Applications Information Section. This section covers an overview, a description of control modes (Extended Control Mode and Non-Extended Control Mode), and features.

#### **OVERVIEW**

The ADC10D1000/1500 uses a calibrated folding and interpolating architecture that achieves a high 9.1/9.0 Effective Number of Bits (ENOB). The use of folding amplifiers greatly reduces the number of comparators and power consumption. Interpolation reduces the number of front-end amplifiers required, minimizing the load on the input signal and further reducing power requirements. In addition to correcting other non-idealities, on-chip calibration reduces the INL bow often seen with folding architectures. The result is an extremely fast, high performance, low power converter.

The analog input signal (which is within the converter's input voltage range) is digitized to ten bits at speeds of 200/200 MSPS to 1.0/1.5 GSPS, typical. Differential input voltages below negative full-scale will cause the output word to consist of all zeroes. Differential input voltages above positive full-scale will cause the output word to consist of all ones. Either of these conditions at the I- or Q-input will cause the Out-of-Range I-channel or Q-channel output (ORI or ORQ), respectively, to output a logic-high signal.

In ECM, an expanded feature set is available via the Serial Interface. The ADC10D1000/1500 builds upon previous architectures, introducing a new AutoSync feature for multi-chip synchronization and increasing to 15-bit for gain and 12-bit plus sign for offset the independent programmable adjustment for each channel.

Each channel has a selectable output demultiplexer which feeds two LVDS buses. If the 1:2 Demux Mode is selected, the output data rate is reduced to half the input sample rate on each bus. When Non-Demux Mode is selected, the output data rate on each channel is at the same rate as the input sample clock and only one 10-bit bus per channel is active.

#### **CONTROL MODES**

The ADC10D1000/1500 may be operated in one of two control modes: Non-extended Control Mode (Non-ECM) or Extended Control Mode (ECM). In the simpler Non-ECM (also sometimes referred to as Pin Control Mode), the user affects available configuration and control of the device through the control pins. The ECM provides additional configuration and control options through a serial interface and a set of 16 registers, most of which are available to the customer.

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### Non-Extended Control Mode

In Non-extended Control Mode (Non-ECM), the Serial Interface is not active and all available functions are controlled via various pin settings. Non-ECM is selected by setting the  $\overline{\text{ECE}}$  Pin to logic-high. Note that, for the control pins, "logic-high" and "logic-low" refer to  $V_A$  and GND, respectively. Nine dedicated control pins provide a wide range of control for the ADC10D1000/1500 and facilitate its operation. These control pins provide DES Mode selection, Demux Mode selection, DDR Phase selection, execute Calibration, Calibration Delay setting, Power Down I-channel, Power Down Q-channel, Test Pattern Mode selection, and Full-Scale Input Range selection. In addition to this, two dual-purpose control pins provide for AC/DC-coupled Mode selection and LVDS output common-mode voltage selection. See Table 7 for a summary.

**Table 7. Non-ECM Pin Summary** 

Pin Name	Logic-Low Logic-High		Floating
Dedicated Control Pins	S		
DES	Non-DES Mode	DES Mode	Not valid
NDM	Demux Mode	Non-Demux Mode	Not valid
DDRPh	0° Mode	90° Mode	Not valid
CAL	See Calib	ration Pin (CAL)	Not valid
CalDly	Shorter delay	Longer delay	Not valid
PDI	I-channel active	Power Down I-channel	Power Down I-channel
PDQ	Q-channel active	Power Down Q-channel	Power Down Q-channel
TPM	Non-Test Pattern Mode	Test Pattern Mode	Not valid
FSR	Lower FS input Range	Higher FS input Range	Not valid
Dual-purpose Control	Pins		
V <sub>CMO</sub>	AC-coupled operation	Not allowed	DC-coupled operation
V <sub>BG</sub>	Not allowed	Higher LVDS common-mode voltage	Lower LVDS common-mode voltage

#### **Dual Edge Sampling Pin (DES)**

The Dual Edge Sampling (DES) Pin selects whether the ADC10D1000/1500 is in DES Mode (logic-high) or Non-DES Mode (logic-low). DES Mode means that a single input is sampled by both I- and Q-channels in a time-interleaved manner and the other input is deactivated. One of the ADCs samples the input signal on the rising sampling clock edge (duty cycle corrected); the other ADC samples the input signal on the falling sampling clock edge (duty cycle corrected). In Non-ECM, only the I-input may be used for DES Mode, a.k.a. "DESI Mode". In ECM, the Q-input may be selected via the DEQ Bit (Addr: 0h, Bit: 6), a.k.a. "DESQ Mode". In ECM, both the I-and Q-channel inputs may be selected, a.k.a. "DESIQ Mode".

To use this feature in ECM, use the DES bit in the Configuration Register (Addr: 0h; Bit: 7). See DES/Non-DES Mode for more information.

#### Non-Demultiplexed Mode Pin (NDM)

The Non-Demultiplexed Mode (NDM) Pin selects whether the ADC10D1000/1500 is in Demux Mode (logic-low) or Non-Demux Mode (logic-high). In Non-Demux Mode, the data from the input is produced at the sampled rate at a single 10-bit output bus. In Demux Mode, the data from the input is produced at half the sampled rate at twice the number of output buses. For Non-DES Mode, each I- or Q-channel will produce its data on one or two buses for Non-Demux or Demux Mode, respectively. For DES Mode, the Q-channel will produce its data on two or four buses for Non-Demux or Demux Mode, respectively.

This feature is pin-controlled only and remains active during both Non-ECM and ECM. See Demux/Non-demux Mode for more information.

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#### **Dual Data Rate Phase Pin (DDRPh)**

The Dual Data Rate Phase (DDRPh) Pin selects whether the ADC10D1000/1500 is in 0° Mode (logic-low) or 90° Mode (logic-high). The Data is always produced in DDR Mode on the ADC10D1000/1500. The Data may transition either with the DCLK transition (0° Mode) or halfway between DCLK transitions (90° Mode). The DDRPh Pin selects 0° Mode or 90° Mode for both the I-channel: DI- and DId-to-DCLKI phase relationship and for the Q-channel: DQ- and DQd-to-DCLKQ phase relationship.

To use this feature in ECM, use the DPS bit in the Configuration Register (Addr: 0h; Bit: 14). See DDR Clock Phase for more information.

#### Calibration Pin (CAL)

The Calibration (CAL) Pin may be used to execute an on-command calibration or to disable the power-on calibration. The effect of calibration is to maximize the dynamic performance. To initiate an on-command calibration via the CAL pin, bring the CAL pin high for a minimum of t<sub>CAL H</sub> input clock cycles after it has been low for a minimum of t<sub>CAL</sub> input clock cycles. Holding the CAL pin high upon power-on will prevent execution of the power-on calibration. In ECM, this pin remains active and is logically OR'd with the CAL bit.

To use this feature in ECM, use the CAL bit in the Configuration Register (Addr: 0h; Bit: 15). See Calibration Feature for more information.

#### Calibration Delay Pin (CalDly)

The Calibration Delay (CalDly) Pin selects whether a shorter or longer delay time is present, after the application of power, until the start of the power-on calibration. The actual delay time is specified as t<sub>CalDly</sub> and may be found in Converter Electrical Characteristics - AC Electrical Characteristics. This feature is pin-controlled only and remains active in ECM. It is recommended to select the desired delay time prior to power-on and not dynamically alter this selection.

See Calibration Feature for more information.

#### Power Down I-channel Pin (PDI)

The Power Down I-channel (PDI) Pin selects whether the I-channel is powered down (logic-high) or active (logiclow). The digital data output pins, DI and DId, (both positive and negative) are put into a high impedance state when the I-channel is powered down. Upon return to the active state, the pipeline will contain meaningless information and must be flushed. The supply currents (typicals and limits) are available for the I-channel powered down or active and may be found in Converter Electrical Characteristics - Power Supply Characteristics. The device should be recalibrated following a power-cycle of PDI (or PDQ).

This pin remains active in ECM. In ECM, either this pin or the PDI bit (Addr: 0h; Bit: 11) in the Control Register may be used to power-down the I-channel. See Power Down for more information.

#### Power Down Q-channel Pin (PDQ)

The Power Down Q-channel (PDQ) Pin selects whether the Q-channel is powered down (logic-high) or active (logic-low). This pin functions similarly to the PDI pin, except that it applies to the Q-channel. The PDI and PDQ pins function independently of each other to control whether each I- or Q-channel is powered down or active.

This pin remains active in ECM. In ECM, either this pin or the PDQ bit (Addr: 0h; Bit: 10) in the Control Register may be used to power-down the Q-channel. See Power Down for more information.

#### **Test Pattern Mode Pin (TPM)**

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The Test Pattern Mode (TPM) Pin selects whether the output of the ADC10D1000/1500 is a test pattern (logichigh) or the converted analog input (logic-low). The ADC10D1000/1500 can provide a test pattern at the four output buses independently of the input signal to aid in system debug. In TPM, the ADC is disengaged and a test pattern generator is connected to the outputs, including ORI and ORQ. SeeTest Pattern Mode for more information.

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#### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### Full-Scale Input Range Pin (FSR)

The Full-Scale Input Range (FSR) Pin selects whether the full-scale input range for both the I- and Q-channel is higher (logic-high) or lower (logic-low). The input full-scale range is specified as V<sub>IN\_FSR</sub> in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics. In Non-ECM, the full-scale input range for each I- and Q-channel may not be set independently, but it is possible to do so in ECM. The device must be calibrated following a change in FSR to obtain optimal performance.

To use this feature in ECM, use the Configuration Registers (Addr: 3h and Bh). See Input Control and Adjust for more information.

#### AC/DC-Coupled Mode Pin (V<sub>CMO</sub>)

The  $V_{CMO}$  Pin serves a dual purpose. When functioning as an output, it provides the optimal common-mode voltage for the DC-coupled analog inputs. When functioning as an input, it selects whether the device is AC-coupled (logic-low) or DC-coupled (floating). This pin is always active, in both ECM and Non-ECM.

#### LVDS Output Common-mode Pin (V<sub>BG</sub>)

The  $V_{BG}$  Pin serves a dual purpose. When functioning as an output, it provides the bandgap reference. When functioning as an input, it selects whether the LVDS output common-mode voltage is higher (logic-high) or lower (floating). The LVDS output common-mode voltage is specified as  $V_{OS}$  and may be found in Converter Electrical Characteristics – Digital Control and Output Pin Characteristics. This pin is always active, in both ECM and Non-ECM.

#### **Extended Control Mode**

In Extended Control Mode (ECM), most functions are controlled via the Serial Interface. In addition to this, several of the control pins remain active. See Table 10 for details. ECM is selected by setting the ECE Pin to logic-low. If the ECE Pin is set to logic-high (Non-ECM), then the registers are reset to their default values. So, a simple way to reset the registers is by toggling the ECE pin. Four pins on the ADC10D1000/1500 control the Serial Interface: SCS, SCLK, SDI and SDO. This section covers the Serial Interface. The Register Definitions are located at the end of the datasheet so that they are easy to find, see Register Definitions.

#### The Serial Interface

The ADC10D1000/1500 offers a Serial Interface that allows access to the sixteen control registers within the device. The Serial Interface is a generic 4-wire (optionally 3-wire) synchronous interface that is compatible with SPI type interfaces that are used on many micro-controllers and DSP controllers. Each serial interface access cycle is exactly 24 bits long. A register-read or register-write can be accomplished in one cycle. The signals are defined in such a way that the user can opt to simply join SDI and SDO signals in his system to accomplish a single, bidirectional SDI/O signal. A summary of the pins for this interface may be found in Table 8. See Figure 11 for the timing diagram and Converter Electrical Characteristics – AC Electrical Characteristics for timing specification details. Control register contents are retained when the device is put into power-down mode.

**Table 8. Serial Interface Pins** 

Pin	Name	
C4	SCS (Serial Chip Select bar)	
C5	SCLK (Serial Clock)	
B4	SDI (Serial Data In)	
A3	SDO (Serial Data Out)	

**SCS**: Each assertion (logic-low) of this signal starts a new register access, i.e. the SDI command field must be ready on the following SCLK rising edge. The user is required to de-assert this signal after the 24th clock. If the SCS is de-asserted before the 24th clock, no data read/write will occur. For a read operation, if the SCS is asserted longer than 24 clocks, the SDO output will hold the D0 bit until SCS is de-asserted. For a write operation, if the SCS is asserted longer than 24 clocks, data write will occur normally through the SDI input upon the 24th clock. Setup and hold times, t<sub>SCS</sub> and t<sub>HCS</sub>, with respect to the SCLK must be observed. SCS must be toggled in between register access cycles.

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### ADC10D1000, ADC10D1500

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**SCLK**: This signal is used to register the input data (SDI) on the rising edge; and to source the output data (SDO) on the falling edge. The user may disable the clock and hold it at logic-low. There is no minimum frequency requirement for SCLK; see f<sub>SCLK</sub> in Converter Electrical Characteristics – AC Electrical Characteristics for more details.

**SDI:** Each register access requires a specific 24-bit pattern at this input, consisting of a command field and a data field. When in read mode, the data field is high impedance in case the bidirectional SDI/O option is used. Setup and hold times, t<sub>SH</sub> and t<sub>SSU</sub>, with respect to the SCLK must be observed.

**SDO:** This output is normally tri-stated and is driven only when  $\overline{SCS}$  is asserted, the first 8 bits of command data have been received and it is a READ operation. The data is shifted out, MSB first, starting with the 8th clock's falling edge. At the end of the access, when  $\overline{SCS}$  is de-asserted, this output is tri-stated once again. If an invalid address is accessed, the data sourced will consist of all zeroes. If it is a read operation, there will be a bus turnaround time,  $t_{BSU}$ , from when the last bit of the command field was read in until the first bit of the data field is written out.

Table 9 shows the Serial Interface bit definitions.

Table 9. Command and Data Field Definitions

Bit No.	Name	Comments
1	Read/Write (R/W)	1 <b>b</b> indicates a read operation 0 <b>b</b> indicates a write operation
2-3	Reserved	Bits must be set to 10b
4-7	A<3:0>	16 registers may be addressed. The order is MSB first
8	X	This is a "don't care" bit
9-24	D<15:0>	Data written to or read from addressed register

The serial data protocol is shown for a read and write operation in Figure 67 and Figure 68, respectively.

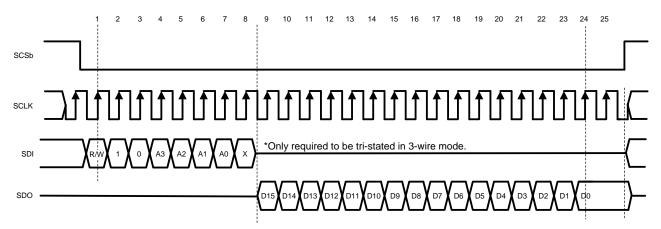


Figure 67. Serial Data Protocol - Read Operation

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### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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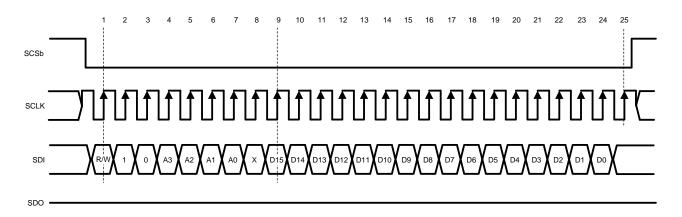


Figure 68. Serial Data Protocol - Write Operation

#### **FEATURES**

The ADC10D1000/1500 offers many features to make the device convenient to use in a wide variety of applications. Table 10 is a summary of the features available, as well as details for the control mode chosen.

**Table 10. Features and Modes** 

Feature	Non-ECM	Control Pin Active in ECM	ECM	Default ECM State
<del>,</del>	*	Input Control and Adjus	st	
AC/DC-coupled Mode Selection	Selected via V <sub>CMO</sub> (Pin C2)	Yes	Not available	N/A
Input Full-scale Range Adjust	Selected via FSR (Pin Y3)	No	Selected via the Config Reg (Addr: 3h and Bh)	Mid FSR value
Input Offset Adjust Setting	Not available	N/A	Selected via the Config Reg (Addr: 2 <b>h</b> and A <b>h</b> )	Offset = 0 mV
LC Filter on Clock	Not available	N/A	Selected via the Config Reg (Addr: D <b>h</b> )	LC Filter off
DES/Non-DES Mode Selection	Selected via DES (Pin V5)	No	Selected via the DES Bit (Addr: 0h; Bit: 7)	Non-DES Mode
Sampling Clock Phase Adjust	Not available	N/A	Selected via the Config Reg (Addr: Ch and Dh)	t <sub>AD</sub> adjust disabled
V <sub>CMO</sub> Adjust	Not available	N/A	Selected via the Config Reg (Addr: 1 <b>h</b> )	Default V <sub>CMO</sub>
	(	Output Control and Adju	ıst	
DDR Clock Phase Selection	Selected via DDRPh (Pin W4)	No	Selected via the DPS Bit (Addr: 0h; Bit: 14)	0° Mode
LVDS Differential Output Voltage Amplitude Selection	Higher amplitude only	N/A	Selected via the OVS Bit (Addr: 0h; Bit: 13)	Higher amplitude
LVDS Common-Mode Output Voltage Amplitude Selection	Selected via V <sub>BG</sub> (Pin B1)	Yes	Not available	N/A
Output Formatting Selection	Offset Binary only	N/A	Selected via the 2SC Bit (Addr: 0h; Bit: 4)	Offset Binary
Test Pattern Mode at Output	Selected via TPM (Pin A4)	No	Selected via the TPM Bit (Addr: 0h; Bit: 12)	TPM disabled

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#### Table 10. Features and Modes (continued)

Feature	Non-ECM	Control Pin Active in ECM	ЕСМ	Default ECM State
Demux/Non-Demux Mode Selection	Selected via NDM (Pin A5)	Yes	Not available	N/A
AutoSync	Not available	N/A	Selected via the Config Reg (Addr: E <b>h</b> )	Master Mode, RCOut1/2 disabled
DCLK Reset	Not available	N/A	Selected via the Config Reg (Addr: E <b>h</b> )	DCLK Reset disabled
		Calibration		
On-command Calibration	Selected via CAL (Pin D6)	Yes	Selected via the CAL Bit (Addr: 0h; Bit: 15)	N/A (CAL = 0)
Power-on Calibration Delay Selection	Selected via CalDly (Pin V4)	Yes	Not available	N/A
Calibration Adjust	Not available	N/A	Selected via the Config Reg (Addr: 4 <b>h</b> )	t <sub>CAL</sub>
		Power-Down		
Power down I-channel	Selected via PDI (Pin U3)	Yes	Selected via the PDI Bit (Addr: 0h; Bit: 11)	I-channel operational
Power down Q-channel	Selected via PDQ (Pin V3)	Yes	Selected via the PDQ Bit (Addr: 0h; Bit: 10)	Q-channel operational

<sup>&</sup>quot;N/A" means "Not Applicable."

#### Input Control and Adjust

There are several features and configurations for the input of the ADC10D1000/1500 so that it may be used in many different applications. This section covers AC/DC-coupled Mode, input full-scale range adjust, input offset adjust, DES/Non-DES Mode, sampling clock phase adjust, an LC filter on the sampling clock, and  $V_{CMO}$  Adjust.

#### **AC/DC-coupled Mode**

The analog inputs may be AC or DC-coupled. See AC/DC-Coupled Mode Pin ( $V_{CMO}$ ) for information on how to select the desired mode and DC-coupled Input Signals and AC-coupled Input Signals for applications information.

#### Input Full-Scale Range Adjust

The input full-scale range for the ADC10D1000/1500 may be adjusted via Non-ECM or ECM. In Non-ECM, a control pin selects a higher or lower value; see Full-Scale Input Range Pin (FSR). In ECM, the input full-scale range may be adjusted with 15-bits of precision. See  $V_{\text{IN\_FSR}}$  in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics for electrical specification details. Note that the higher and lower full-scale input range settings in Non-ECM correspond to the mid and min full-scale input range settings in ECM. It is necessary to execute an on-command calibration following a change of the input full-scale range. See Register Definitions for information about the registers.

#### **Input Offset Adjust**

The input offset adjust for the ADC10D1000/1500 may be adjusted with 12-bits of precision plus sign via ECM. See Register Definitions for information about the registers.



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#### ADC10D1000, ADC10D1500



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#### **DES/Non-DES Mode**

The ADC10D1000/1500 can operate in Dual-Edge Sampling (DES) or Non-DES Mode. The DES Mode allows for one of the ADC10D1000/1500's inputs to be sampled by both channels' ADCs. One ADC samples the input on the rising edge of the sampling clock and the other ADC samples the same input on the falling edge of the sampling clock. A single input is thus sampled twice per clock cycle, resulting in an overall sample rate of twice the sampling clock frequency, e.g. 2.0/3.0 GSPS with a 1.0/1.5 GHz sampling clock. See Dual Edge Sampling Pin (DES) for information on how to select the desired mode. Since DES Mode uses both I- and Q-channels to process the input signal, both channels must be powered up for the DES Mode to function properly.

In Non-ECM, only the I-input may be used for the DES Mode input. In ECM, either the I- or Q-input may be selected by first using the DES bit (Addr: 0h, Bit 7) to select the DES Mode. The DEQ Bit (Addr: 0h, Bit: 6) is used to select the Q-input, but the I-input is used by default. Also, both I- and Q-inputs may be driven externally, i.e. DESIQ Mode, by using the DIQ bit (Addr: 0h, Bit 5). See THE ANALOG INPUTS for more information about how to drive the ADC in DES Mode.

The DESIQ Mode results in the best bandwidth. In general, the bandwidth decreases from Non-DES Mode to DES Mode (specifically, DESI or DESQ) because both channels are sampling off the same input signal and non-ideal effects introduced by interleaving the two channels lower the bandwidth. Driving both I- and Q-channels externally (DESIQ Mode) results in better bandwidth for the DES Mode because each channel is being driven, which reduces routing losses (increases bandwidth).

In the DES Mode, the outputs must be carefully interleaved in order to reconstruct the sampled signal. If the device is programmed into the 1:4 Demux DES Mode, the data is effectively demultiplexed by 1:4. If the sampling clock is 1.0/1.5 GHz, the effective sampling rate is doubled to 2.0/3.0 GSPS and each of the 4 output buses has an output rate of 500 MSPS. All data is available in parallel. To properly reconstruct the sampled waveform, the four bytes of parallel data that are output with each DCLK must be correctly interleaved. The sampling order is as follows, from the earliest to the latest: DQd, Dld, DQ, Dl. See Figure 7. If the device is programmed into the Non-Demux DES Mode, two bytes of parallel data are output with each edge of the DCLK in the following sampling order, from the earliest to the latest: DQ, Dl. See Figure 8.

The performance of the ADC10D1000/1500 in DES Mode depends on how well the two channels are interleaved, i.e. that the clock samples either channel with precisely a 50% duty-cycle, each channel has the same offset (nominally code 511/512), and each channel has the same full-scale range. The ADC10D1000/1500 includes an automatic clock phase background adjustment in DES Mode to automatically and continuously adjust the clock phase of the I- and Q-channels, which also removes the need to adjust the clock phase setting manually. A difference exists in the typical offset between the I- and Q-channels, which can be removed via the offset adjust feature in ECM, to optimize DES Mode performance. If possible, it is recommended to use the Q-input for better DES Mode performance with no offset adjustment required. To adjust the I- or Q-channel offset, measure a histogram of the digital data and adjust the offset via the Control Register until the histogram is centered at code 511/512. Similarly, the full-scale range of each channel may be adjusted for optimal performance.

#### Sampling Clock Phase Adjust

The sampling clock (CLK) phase may be delayed internally to the ADC up to 825 ps in ECM. This feature is intended to help the system designer remove small imbalances in clock distribution traces at the board level when multiple ADCs are used, or to simplify complex system functions such as beam steering for phase array antennas.

Additional delay in the clock path also creates additional jitter, so a clock jitter-cleaner is made available when using the sampling clock phase adjust, see LC Filter on Sampling Clock. Nevertheless, because the sampling clock phase adjust delays all clocks, including the DCLKs and output data, the user is strongly advised to use the minimal amount of adjustment and verify the net benefit of this feature in his system before relying on it.

#### LC Filter on Sampling Clock

A LC bandpass filter is available on the ADC10D1000/1500 sampling clock to clean jitter on the incoming clock. This feature is only available when the CLK phase adjust feature is also used. This feature was designed to minimize the dynamic performance degradation resulting from additional clock jitter as much as possible. It is available in ECM via the LCF (LC Filter) bits in the Control Register (Addr: Dh, Bits 7:0).

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If the clock phase adjust feature is enabled, the sampling clock passes through additional gate delay, which adds jitter to the clock signal. The LC filter helps to remove this additional jitter, so it is only available when the clock phase adjust feature is also enabled. To enable both features, use SA (Addr: Dh, Bit 8). The LCF bits are thermometer encoded and may be used to set a filter center frequency ranging from 0.8 GHz to 1.5 GHz; see Table 11.

Table 11. LC Filter Code vs. fc

LCF(7:0)	LCF(7:0)	f <sub>c</sub> (GHz)
0	0000 0000 <b>b</b>	1.5
1	0000 0001 <b>b</b>	1.4
2	0000 0011 <b>b</b>	1.3
3	0000 0111 <b>b</b>	1.2
4	0000 1111 <b>b</b>	1.1
5	0001 1111 <b>b</b>	1.0
6	0011 1111 <b>b</b>	0.92
7	0111 1111 <b>b</b>	0.85
8	1111 1111 <b>b</b>	0.8

The LC filter is a second-order bandpass filter, which has the following simulated bandwidth for a center frequency at 1GHz, see Table 12.

Table 12. LC Filter Bandwidth vs. Level

Bandwidth at [dB]	-3	-6	-9	-12
Bandwidth [MHz]	±135	±235	±360	±525

#### V<sub>CMO</sub> Adjust

The  $V_{CMO}$  of the ADC10D1000/1500 is generated as a buffered version of the internal bandgap reference; see  $V_{CMO}$  in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics. This pin provides an output voltage which is the optimal common-mode voltage for the input signal and should be used to set the common-mode voltage of the driving buffer. However, in order to accommodate larger signals at the analog inputs, the  $V_{CMO}$  may be adjust to a lower value. From its typical default value, the  $V_{CMO}$  may be lowered by approximately 200 mV via the Control Register 1h. See Register Definitions for more information. Adjusting the  $V_{CMO}$  away from its optimal value will also degrade the dynamic performance; see ENOB vs.  $V_{CMO}$  in Typical Performance Plots for a typical plot. The performance of the device, when using a  $V_{CMO}$  other than the default value, is not specified.

#### **Output Control and Adjust**

There are several features and configurations for the output of the ADC10D1000/1500 so that it may be used in many different applications. This section covers DDR clock phase, LVDS output differential and common-mode voltage, output formatting, Demux/Non-demux Mode, and Test Pattern Mode.

#### **DDR Clock Phase**

The ADC10D1000/1500 output data is always delivered in Double Data Rate (DDR). With DDR, the DCLK frequency is half the data rate and data is sent to the outputs on both edges of DCLK; see Figure 69. The DCLK-to-Data phase relationship may be either 0° or 90°. For 0° Mode, the Data transitions on each edge of the DCLK. Any offset from this timing is  $t_{OSK}$ ; see Converter Electrical Characteristics – AC Electrical Characteristics for details. For 90° Mode, the DCLK transitions in the middle of each Data cell. Setup and hold times for this transition,  $t_{SU}$  and  $t_{H}$ , may also be found in Converter Electrical Characteristics – AC Electrical Characteristics. The DCLK-to-Data phase relationship may be selected via the DDRPh Pin in Non-ECM (see Dual Data Rate Phase Pin (DDRPh)) or the DPS bit in the Configuration Register (Addr: 0h; Bit: 14) in ECM.

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### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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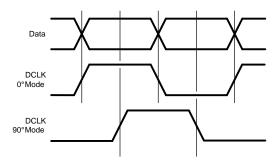


Figure 69. DDR DCLK-to-Data Phase Relationship

#### **LVDS Output Differential Voltage**

The ADC10D1000/1500 is available with a selectable higher or lower LVDS output differential voltage. This parameter is  $V_{OD}$  and may be found in Converter Electrical Characteristics – Digital Control and Output Pin Characteristics. The desired voltage may be selected via the OVS Bit (Addr: 0h, Bit 13); see Register Definitions for more information.

#### LVDS Output Common-Mode Voltage

The ADC10D1000/1500 is available with a selectable higher or lower LVDS output common-mode voltage. This parameter is  $V_{OS}$  and may be found in Converter Electrical Characteristics – Digital Control and Output Pin Characteristics. See LVDS Output Common-mode Pin ( $V_{BG}$ ) for information on how to select the desired voltage.

#### **Output Formatting**

The formatting at the digital data outputs may be either offset binary or two's complement. The default formatting is offset binary, but two's complement may be selected via the 2SC Bit (Addr: 0h, Bit 4); see Register Definitions for more information.

#### **Demux/Non-demux Mode**

The ADC10D1000/1500 may be in one of two demultiplex modes: Demux Mode or Non-Demux Mode (also sometimes referred to as 1:1 Demux Mode). In Non-Demux Mode, the data from the input is simply output at the sampling rate at which it was sampled on one 10-bit bus. In Demux Mode, the data from the input is output at half the sampling rate, on twice the number of buses. See Figure 1. Demux/Non-Demux Mode may only be selected by the NDM pin; see Non-Demultiplexed Mode Pin (NDM). In Non-DES Mode, the output data from each channel may be demultiplexed by a factor of 1:2 (1:2 Demux Non-DES Mode) or not demultiplexed (Non-Demux Non-DES Mode). In DES Mode, the output data from both channels interleaved may be demultiplexed (1:4 Demux DES Mode) or not demultiplexed (Non-Demux DES Mode).

#### **Test Pattern Mode**

The ADC10D1000/1500 can provide a test pattern at the four output buses independently of the input signal to aid in system debug. In Test Pattern Mode, the ADC is disengaged and a test pattern generator is connected to the outputs, including ORI and ORQ. The test pattern output is the same in DES Mode or Non-DES Mode. Each port is given a unique 10-bit word, alternating between 1's and 0's. When the part is programmed into the Demux Mode, the test pattern's order is described in Table 13. If the I- or Q-channel is powered down, the test pattern will not be output for that channel.

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Table 13. Test Pattern by Output Port in Demux Mode

Time	Qd	ld	Q	I	ORQ	ORI	Comments
T0	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T1	3FF <b>h</b>	3FE <b>h</b>	3FD <b>h</b>	3FB <b>h</b>	1 <b>b</b>	1 <b>b</b>	Pattern
T2	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	Sequence
T3	3FF <b>h</b>	3FE <b>h</b>	3FD <b>h</b>	3FB <b>h</b>	1 <b>b</b>	1 <b>b</b>	n
T4	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T5	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T6	3FF <b>h</b>	3FE <b>h</b>	3FD <b>h</b>	3FB <b>h</b>	1b	1 <b>b</b>	Pattern
T7	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	Sequence
T8	3FF <b>h</b>	3FE <b>h</b>	3FD <b>h</b>	3FB <b>h</b>	1 <b>b</b>	1 <b>b</b>	n+1
T9	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T10	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T11	3FF <b>h</b>	3FE <b>h</b>	3FD <b>h</b>	3FB <b>h</b>	1 <b>b</b>	1 <b>b</b>	Pattern Sequence n+2
T12	000 <b>h</b>	001 <b>h</b>	002 <b>h</b>	004 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T13							

When the part is programmed into the Non-Demux Mode, the test pattern's order is described in Table 14.

Table 14. Test Pattern by Output Port in Non-Demux Mode

Time	I	Q	ORI	ORQ	Comments
T0	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T1	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T2	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
T3	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
T4	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	Pattern
T5	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	Sequence <b>n</b>
T6	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T7	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
T8	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
Т9	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
T10	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	
T11	001 <b>h</b>	000 <b>h</b>	0 <b>b</b>	0 <b>b</b>	Pattern
T12	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	Sequence n+1
T13	3FE <b>h</b>	3FF <b>h</b>	1 <b>b</b>	1 <b>b</b>	
T14					

#### Calibration Feature

The ADC10D1000/1500 calibration must be run to achieve specified performance. The calibration procedure is exactly the same regardless of how it was initiated or when it is run. Calibration trims the analog input differential termination resistors, the CLK input resistor, and sets internal bias currents which affect the linearity of the converter. This minimizes full-scale error, offset error, DNL and INL, resulting in maximizing the dynamic performance, as measured by: SNR, THD, SINAD (SNDR) and ENOB.

#### **Calibration Control Pins and Bits**

Table 15 is a summary of the pins and bits used for calibration. See Ball Descriptions and Equivalent Circuits for complete pin information and Figure 10 for the timing diagram.

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55



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#### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### **Table 15. Calibration Pins**

Pin/Bit	Name	Function
D6 (Addr: 0 <b>h</b> ; Bit 15)	CAL (Calibration)	Initiate calibration
V4	CalDly (Calibration Delay)	Select calibration delay
Addr: 4h	Calibration Adjust	Adjust calibration sequence and mode
B5	CalRun (Calibration Running)	Indicates while calibration is running
C1/D2	Rtrim+/- (Input termination trim resistor)	External resistor used to calibrate analog and CLK inputs
C3/D3	Rext+/- (External Reference resistor)	External resistor used to calibrate internal linearity

#### How to Execute a Calibration

Calibration may be initiated by holding the CAL pin low for at least  $t_{CAL\_L}$  clock cycles, and then holding it high for at least another  $t_{CAL\_H}$  clock cycles, as defined in Converter Electrical Characteristics – AC Electrical Characteristics. The minimum  $t_{CAL\_H}$  and  $t_{CAL\_H}$  input clock cycle sequences are required to ensure that random noise does not cause a calibration to begin when it is not desired. The time taken by the calibration procedure is specified as  $t_{CAL}$ . The CAL Pin is active in both ECM and Non-ECM. However, in ECM, the CAL Pin is logically OR'd with the CAL Bit, so both the pin and bit are required to be set low before executing another calibration via either pin or bit.

#### **Power-on Calibration**

For standard operation, power-on calibration begins after a time delay following the application of power, as determined by the setting of the CalDly Pin and measured by  $t_{CalDly}$  (see Converter Electrical Characteristics – AC Electrical Characteristics). This delay allows the power supply to come up and stabilize before the power-on calibration takes place. The best setting (short or long) of the CalDly Pin depends upon the settling time of the power supply.

It is strongly recommended to set CalDly Pin (to either logic-high or logic-low) before powering the device on since this pin affects the power-on calibration timing. This may be accomplished by setting CalDly via an external  $1k\Omega$  resistor connected to GND or  $V_A$ . If the CalDly Pin is toggled while the device is powered-on, it can execute a calibration even though the CAL Pin/Bit remains logic-low.

The power-on calibration will be not be performed if the CAL pin is logic-high at power-on. In this case, the calibration cycle will not begin until the on-command calibration conditions are met. The ADC10D1000/1500 will function with the CAL pin held high at power up, but no calibration will be done and performance will be impaired.

If it is necessary to toggle the CalDly Pin during the system power up sequence, then the CAL Pin/Bit must be set to logic-high during the toggling and afterwards for 10<sup>9</sup> Sampling Clock cycles. This will prevent the power-on calibration, so an on-command calibration must be executed or the performance will be impaired.

#### **On-command Calibration**

In addition to the power-on calibration, it is recommended to execute an on-command calibration whenever the settings or conditions to the device are altered significantly, in order to obtain optimal parametric performance. Some examples include: changing the FSR via either ECM or Non-ECM, power-cycling either channel, and switching into or out of DES Mode. For best performance, it is also recommended that an on-command calibration be run 20 seconds or more after application of power and whenever the operating temperature changes significantly, relative to the specific system performance requirements.

Due to the nature of the calibration feature, it is recommended to avoid unnecessary activities on the device while the calibration is taking place. For example, do not read or write to the Serial Interface or use the DCLK Reset feature while calibrating the ADC. Doing so will impair the performance of the device until it is re-calibrated correctly. Also, it is recommended to not apply a strong narrow-band signal to the analog inputs during calibration because this may impair the accuracy of the calibration; broad spectrum noise is acceptable.

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56

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ADC10D1000, ADC10D1500

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SNAS462Q - OCTOBER 2008 - REVISED MARCH 2013

#### **Calibration Adjust**

The calibration event itself may be adjusted, for sequence and mode. This feature can be used if a shorter calibration time than the default is required; see  $t_{CAL}$  in Converter Electrical Characteristics – AC Electrical Characteristics. However, the performance of the device, when using a shorter calibration time than the default setting, is not specified.

The calibration sequence may be adjusted via CSS (Addr: 4h, Bit 14). The default setting of CSS = 1b executes both  $R_{\text{IN}}$  and  $R_{\text{IN\_CLK}}$  Calibration (using Rtrim) and internal linearity Calibration (using Rext). Executing a calibration with CSS = 0b executes only the internal linearity Calibration. The first time that Calibration is executed, it must be with CSS = 1b to trim  $R_{\text{IN}}$  and  $R_{\text{IN\_CLK}}$ . However, once the device is at its operating temperature and  $R_{\text{IN}}$  has been trimmed at least one time, it will not drift significantly. To save time in subsequent calibrations, trimming  $R_{\text{IN}}$  and  $R_{\text{IN}}$  cut may be skipped, i.e. by setting CSS = 0b.

The mode may be changed, to save calibration execution time for the internal linearity Calibration. See  $t_{CAL}$  in Converter Electrical Characteristics – AC Electrical Characteristics. Adjusting CMS(1:0) will select three different pre-defined calibration times. A larger amount of time will calibrate each channel more closely to the ideal values, but choosing shorter times will not significantly impact the performance. The fourth setting, CMS(1:0) = 11 $\mathbf{b}$ , is not available.

#### **Read/Write Calibration Settings**

When the ADC performs a calibration, the calibration constants are stored in an array which is accessible via the Calibration Values register (Addr: 5h). To save the time which it takes to execute a calibration,  $t_{CAL}$ , or if re-using a previous calibration result, these values can be read from and written to the register at a later time. For example, if an application requires the same input impedance,  $R_{IN}$ , this feature can be used to load a previously determined set of values. For the calibration values to be valid, the ADC must be operating under the same conditions, including temperature, at which the calibration values were originally read from the ADC.

To read calibration values from the SPI, do the following:

- 1. Set ADC to desired operating conditions.
- 2. Set SSC (Addr: 4h, Bit 7) to 1.
- 3. Power down both I- and Q-channels.
- 4. Read exactly 184 times the Calibration Values register (Addr: 5h). The register values are R0, R1, R2... R183. The contents of R<183:0> should be stored.
- 5. Power up I- and Q-channels to original setting.
- 6. Set SSC (Addr: 4h, Bit 7) to 0.
- 7. Continue with normal operation.

To write calibration values to the SPI, do the following:

- 1. Set ADC to operating conditions at which Calibration Values were previously read.
- 2. Set SSC (Addr: 4h, Bit 7) to 1.
- 3. Power down both I- and Q-channels.
- 4. Write exactly 184 times the Calibration Values register (Addr: 5h). The registers should be written with stored register values R0, R1... R183.
- 5. Make two additional dummy writes of 0000h.
- 6. Power up I- and Q-channels to original setting.
- 7. Set SSC (Addr: 4h, Bit 7) to 0.
- 8. Continue with normal operation.

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### ADC10D1000, ADC10D1500



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#### Calibration and Power-Down

If PDI and PDQ are simultaneously asserted during a calibration cycle, the ADC10D1000/1500 will immediately power down. The calibration cycle will continue when either or both channels are powered back up, but the calibration will be compromised due to the incomplete settling of bias currents directly after power up. Therefore, a new calibration should be executed upon powering the ADC10D1000/1500 back up. In general, the ADC10D1000/1500 should be recalibrated when either or both channels are powered back up, or after one channel is powered down. For best results, this should be done after the device has stabilized to its operating temperature.

#### **Calibration and the Digital Outputs**

During calibration, the digital outputs (including DI, DId, DQ, DQd and OR) are set logic-low, to reduce noise. The DCLK runs continuously during calibration. After the calibration is completed and the CalRun signal is logic-low, it takes an additional 60 Sampling Clock cycles before the output of the ADC10D1000/1500 is valid converted data from the analog inputs. This is the time it takes for the pipeline to flush, as well as for other internal processes.

#### Power Down

On the ADC10D1000/1500, the I- and Q-channels may be powered down individually. This may be accomplished via the control pins, PDI and PDQ, or via ECM. In ECM, the PDI and PDQ pins are logically OR'd with the Control Register setting. See Power Down I-channel Pin (PDI) and Power Down Q-channel Pin (PDQ) for more information.

#### **Applications Information**

#### THE ANALOG INPUTS

The ADC10D1000/1500 will continuously convert any signal which is present at the analog inputs, as long as a CLK signal is also provided to the device. This section covers important aspects related to the analog inputs including: acquiring the input, the reference voltage and FSR, out-of-range indication, AC/DC-coupled signals, and single-ended input signals.

#### Acquiring the Input

Data is acquired at the rising edge of CLK+ in Non-DES Mode and both the falling and rising edges of CLK+ in DES Mode. The digital equivalent of that data is available at the digital outputs a constant number of sampling clock cycles later for the DI, DQ, DId and DQd output buses, a.k.a. Latency, depending on the demultiplex mode which is selected. See  $t_{LAT}$  in Converter Electrical Characteristics – AC Electrical Characteristics. In addition to the Latency, there is a constant output delay,  $t_{OD}$ , before the data is available at the outputs. See  $t_{OD}$  in Converter Electrical Characteristics – AC Electrical Characteristics and the Timing Diagrams.

The output latency versus Demux/Non-Demux Mode is shown in Table 16 and Table 17, respectively. For DES Mode, note that the I- and Q-channel inputs are available in ECM, but only the I-channel input is available in Non-ECM.

Table 16. Output Latency in Demux Mode

Data	Non-DES Mode	DES Mode			
	Non-DES Mode	Q-input*	I-input		
DI	I-input sampled with rise of CLK,	Q-input sampled with rise of CLK,	I-input sampled with rise of CLK,		
	34 cycles earlier	34 cycles earlier	34 cycles earlier		
DQ	Q-input sampled with rise of CLK, 34 cycles earlier	Q-input sampled with fall of CLK, 34.5 cycles earlier	I-input sampled with fall of CLK, 34.5 cycles earlier		
Dld	I-input sampled with rise of CLK,	Q-input sampled with rise of CLK,	I-input sampled with rise of CLK,		
	35 cycles earlier	35 cycles earlier	35 cycles earlier		
DQd	Q-input sampled with rise of CLK,	Q-input sampled with fall of CLK,	I-input sampled with fall of CLK,		
	35 cycles earlier	35.5 cycles earlier	35.5 cycles earlier		

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58

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

Table 17. Output Latency in Non-Demux Mode

Data	Non-DES Mode	DES Mode			
		Q-input*	l-input		
DI	I-input sampled with rise of CLK, 34 cycles earlier	Q-input sampled with rise of CLK, 34 cycles earlier	I-input sampled with rise of CLK, 34 cycles earlier		
DQ	Q-input sampled with rise of CLK, 34 cycles earlier	Q-input sampled with rise of CLK, 34.5 cycles earlier	I-input sampled with rise of CLK, 34.5 cycles earlier		
Dld	No output; high impedance.				
DQd	No output; high impedance.				

<sup>\*</sup>Available in ECM only.

#### Driving the ADC in DES Mode

The ADC10D1000/1500 can be configured as either a 2-channel, 1.0/1.5 GSPS device (Non-DES Mode) or a 1-channel 2.0/3.0 GSPS device (DES Mode). When the device is configured in DES Mode, there is a choice for with which input to drive the single-channel ADC. These are the 3 options:

DES - externally driving the I-channel input only. This is the default selection when the ADC is configured in DES Mode. It may also be referred to as "DESI" for added clarity.

DESQ - externally driving the Q-channel input only.

DESIQ - externally driving both the I- and Q-channel inputs. VinI+ and VinQ+ should be driven with the exact same signal. VinI- and VinQ- should be driven with the exact same signal, which is the differential complement to the one driving VinI+ and VinQ+.

The input impedance for each I- and Q-input is  $100\Omega$  differential (or  $50\Omega$  single-ended), so the trace to each VinI+, VinI-, VinQ+, and VinQ- should always be  $50\Omega$  single-ended. If a single I- or Q-input is being driven, then that input will present a  $100\Omega$  differential load. For example, if a  $50\Omega$  single-ended source is driving the ADC, then a 1:2 balun will transform the impedance to  $100\Omega$  differential. However, if the ADC is being driven in DESIQ Mode, then the  $100\Omega$  differential impedance from the I-input will appear in parallel with the Q-input for a composite load of  $50\Omega$  differential and a 1:1 balun would be appropriate. See Figure 70 for an example circuit driving the ADC in DESIQ Mode. A recommended part selection is using the Mini-Circuits TC1-1-13MA+ balun with Ccouple =  $0.22\mu$ F.

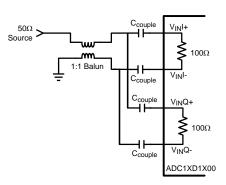


Figure 70. Driving DESIQ Mode

#### **Terminating Unused Analog Inputs**

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In the case that only one channel is used in Non-DES Mode or that the ADC is driven in DESI or DESQ Mode, the unused analog input should be terminated to reduce any noise coupling into the ADC. See Table 18 for details.



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### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### **Table 18. Unused Analog Input Recommended Termination**

Mode	Power Down	Coupling	Recommended Termination
Non-DES	Yes	AC/DC	Tie Unused+ and Unused- to Vbg
DES/ Non-DES	No	DC	Tie Unused+ and Unused- to Vbg
DES/ Non-DES	No	AC	Tie Unused+ to Unused-

#### FSR and the Reference Voltage

The full-scale analog differential input range ( $V_{IN\_FSR}$ ) of the ADC10D1000/1500 is derived from an internal 1.254V bandgap reference. In Non-ECM, this full-scale range has two settings controlled by the FSR Pin; see Full-Scale Input Range Pin (FSR). The FSR Pin operates on both I- and Q-channels. In ECM, the full-scale range may be independently set for each channel via Addr:3h and Bh with 15 bits of precision; see Register Definitions. The best SNR is obtained with a higher full-scale input range, but better distortion and SFDR are obtained with a lower full-scale input range. It is not possible to use an external analog reference voltage to modify the full-scale range, and this adjustment should only be done digitally, as described.

A buffered version of the internal 1.254V bandgap reference voltage is made available at the  $V_{BG}$  Pin for the user. The  $V_{BG}$  pin can drive a load of up to 80 pF and source or sink up to 100  $\mu$ A. It should be buffered if more current than this is required. This pin remains as a constant reference voltage regardless of what full-scale range is selected and may be used for a system reference.  $V_{BG}$  is a dual-purpose pin and it may also be used to select a higher LVDS output common-mode voltage; see LVDS Output Common-mode Pin ( $V_{BG}$ ).

#### **Out-Of-Range Indication**

Differential input signals are digitized to 10 bits, based on the full-scale range. Signal excursions beyond the full-scale range, i.e. greater than  $+V_{IN\_FSR}/2$  or less than  $-V_{IN\_FSR}/2$ , will be clipped at the output. An input signal which is above the FSR will result in all 1's at the output and an input signal which is below the FSR will result in all 0's at the output. When the conversion result is clipped for the I-channel input, the Out-of-Range I-channel (ORI) output is activated such that ORI+ goes high and ORI- goes low while the signal is out of range. This output is active as long as accurate data on either or both of the buses would be outside the range of 000h to 3FFh. The Q-channel has a separate ORQ which functions similarly.

#### Maximum Input Range

The recommended operating and absolute maximum input range may be found in Operating Ratings and Absolute Maximum Ratings, respectively. Under the stated allowed operating conditions, each Vin+ and Vininput pin may be operated in the range from 0V to 2.15V if the input is a continuous 100% duty cycle signal and from 0V to 2.5V if the input is a 10% duty cycle signal. The absolute maximum input range for Vin+ and Vin- is from -0.15V to 2.5V. These limits apply only for AC input signals for which the input common mode voltage is properly maintained.

#### AC-coupled Input Signals

The ADC10D1000/1500 analog inputs require a precise common-mode voltage. This voltage is generated on-chip when AC-coupling Mode is selected. See AC/DC-Coupled Mode Pin (V<sub>CMO</sub>) for more information about how to select AC-coupled Mode.

In AC-coupled Mode, the analog inputs must of course be AC-coupled. For an ADC10D1000/1500 used in a typical application, this may be accomplished by on-board capacitors, as shown in Figure 71. For the ADC10D1000/1500RB, the SMA inputs on the Reference Board are directly connected to the analog inputs on the ADC10D1000/1500, so this may be accomplished by DC blocks (included with the hardware kit).

When the AC-coupled Mode is selected, an analog input channel that is not used (e.g. in DES Mode) should be connected to AC ground, e.g. through capacitors to ground . Do not connect an unused analog input directly to ground.

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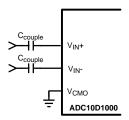


Figure 71. AC-coupled Differential Input

The analog inputs for the ADC10D1000/1500 are internally buffered, which simplifies the task of driving these inputs and the RC pole which is generally used at sampling ADC inputs is not required. If the user desires to place an amplifier circuit before the ADC, care should be taken to choose an amplifier with adequate noise and distortion performance, and adequate gain at the frequencies used for the application.

#### DC-coupled Input Signals

In DC-coupled Mode, the ADC10D1000/1500 differential inputs must have the correct common-mode voltage. This voltage is provided by the device itself at the  $V_{CMO}$  output pin. It is recommended to use this voltage because the  $V_{CMO}$  output potential will change with temperature and the common-mode voltage of the driving device should track this change. Full-scale distortion performance falls off as the input common mode voltage deviates from  $V_{CMO}$ . Therefore, it is recommended to keep the input common-mode voltage within 100 mV of  $V_{CMO}$  (typical), although this range may be extended to ±150 mV (maximum). See  $V_{CMI}$  in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics and ENOB vs.  $V_{CMI}$  in Typical Performance Plots . Performance in AC- and DC-coupled Mode are similar, provided that the input common mode voltage at both analog inputs remains within 100 mV of  $V_{CMO}$ .

#### Single-Ended Input Signals

The analog inputs of the ADC10D1000/1500 are not designed to accept single-ended signals. The best way to handle single-ended signals is to first convert them to differential signals before presenting them to the ADC. The easiest way to accomplish single-ended to differential signal conversion is with an appropriate balun-transformer, as shown in Figure 72.

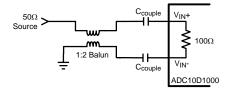


Figure 72. Single-Ended to Differential Conversion Using a Balun

When selecting a balun, it is important to understand the input architecture of the ADC. The impedance of the analog source should be matched to the ADC10D1000/1500's on-chip  $100\Omega$  differential input termination resistor. The range of this termination resistor is specified as  $R_{\text{IN}}$  in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics.

#### THE CLOCK INPUTS

The ADC10D1000/1500 has a differential clock input, CLK+ and CLK-, which must be driven with an AC-coupled, differential clock signal. This provides the level shifting to the clock to be driven with LVDS, PECL, LVPECL, or CML levels. The clock inputs are internally terminated to  $100\Omega$  differential and self-biased. This section covers coupling, frequency range, level, duty-cycle, jitter, and layout considerations.

#### **CLK Coupling**

The clock inputs of the ADC10D1000/1500 must be capacitively coupled to the clock pins as indicated in Figure 73.

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### ADC10D1000, ADC10D1500



SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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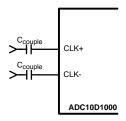


Figure 73. Differential Input Clock Connection

The choice of capacitor value will depend on the clock frequency, capacitor component characteristics and other system economic factors. For example, on the ADC10D1000/1500RB, the capacitors have the value  $C_{couple} = 4.7$  nF which yields a highpass cutoff frequency,  $f_c = 677.2$  kHz.

#### **CLK Frequency**

Although the ADC10D1000/1500 is tested and its performance is specified with a differential 1.0/1.5 GHz sampling clock, it will typically function well over the input clock frequency range; see  $f_{CLK}(min)$  and  $f_{CLK}(max)$  in Converter Electrical Characteristics – AC Electrical Characteristics. Operation up to  $f_{CLK}(max)$  is possible if the maximum ambient temperatures indicated are not exceeded. Operating at sample rates above  $f_{CLK}(max)$  for the maximum ambient temperature may result in reduced device reliability and product lifetime. This is due to the fact that higher sample rates results in higher power consumption and die temperatures. If  $f_{CLK}$  < 300 MHz, enable LFS in the Control Register (Addr: 0h, Bit 8).

#### **CLK Level**

The input clock amplitude is specified as  $V_{IN\_CLK}$  in Converter Electrical Characteristics – Sampling Clock Characteristics . Input clock amplitudes above the max  $V_{IN\_CLK}$  may result in increased input offset voltage. This would cause the converter to produce an output code other than the expected 511/512 when both input pins are at the same potential. Insufficient input clock levels will result in poor dynamic performance. Both of these results may be avoided by keeping the clock input amplitude within the specified limits of  $V_{IN\_CLK}$ .

#### **CLK Duty Cycle**

The duty cycle of the input clock signal can affect the performance of any A/D converter. The ADC10D1000/1500 features a duty cycle clock correction circuit which can maintain performance over the 20%-to-80% specified clock duty-cycle range. This feature is enabled by default and provides improved ADC clocking, especially in the Dual-Edge Sampling (DES) Mode.

#### **CLK Jitter**

High speed, high performance ADCs such as the ADC10D1000/1500 require a very stable input clock signal with minimum phase noise or jitter. ADC jitter requirements are defined by the ADC resolution (number of bits), maximum ADC input frequency and the input signal amplitude relative to the ADC input full scale range. The maximum jitter (the sum of the jitter from all sources) allowed to prevent a jitter-induced reduction in SNR is found to be

$$t_{J(MAX)} = (V_{IN(P-P)}/V_{FSR}) \times (1/(2^{(N+1)} \times \pi \times f_{IN}))$$
(3)

where  $t_{J(MAX)}$  is the rms total of all jitter sources in seconds,  $V_{IN(P-P)}$  is the peak-to-peak analog input signal,  $V_{FSR}$  is the full-scale range of the ADC, "N" is the ADC resolution in bits and  $f_{IN}$  is the maximum input frequency, in Hertz, at the ADC analog input.

t<sub>J(MAX)</sub> is the square root of the sum of the squares (RSS) sum of the jitter from all sources, including: the ADC input clock, system, input signals and the ADC itself. Since the effective jitter added by the ADC is beyond user control, it is recommended to keep the sum of all other externally added jitter to a minimum.

#### CLK Layout

The ADC10D1000/1500 clock input is internally terminated with a trimmed  $100\Omega$  resistor. The differential input clock line pair should have a characteristic impedance of  $100\Omega$  and (when using a balun), be terminated at the clock source in that  $(100\Omega)$  characteristic impedance.

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ADC10D1000, ADC10D1500

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

It is good practice to keep the ADC input clock line as short as possible, to keep it well away from any other signals and to treat it as a transmission line. Otherwise, other signals can introduce jitter into the input clock signal. Also, the clock signal can introduce noise into the analog path if it is not properly isolated.

#### THE LVDS OUTPUTS

The Data, ORI, ORQ, DCLKI and DCLKQ outputs are LVDS. The electrical specifications of the LVDS outputs are compatible with typical LVDS receivers available on ASIC and FPGA chips; but they are not IEEE or ANSI communications standards compliant due to the low +1.9V supply used on this chip. These outputs should be terminated with a  $100\Omega$  differential resistor placed as closely to the receiver as possible. This section covers common-mode and differential voltage, and data rate.

#### Common-mode and Differential Voltage

The LVDS outputs have selectable common-mode and differential voltage,  $V_{OS}$  and  $V_{OD}$ ; see Converter Electrical Characteristics – Digital Control and Output Pin Characteristics. See Output Control and Adjust for more information.

Selecting the higher  $V_{OS}$  will also increase  $V_{OD}$  slightly. The differential voltage,  $V_{OD}$ , may be selected for the higher or lower value. For short LVDS lines and low noise systems, satisfactory performance may be realized with the lower  $V_{OD}$ . This will also result in lower power consumption. If the LVDS lines are long and/or the system in which the ADC10D1000/1500 is used is noisy, it may be necessary to select the higher  $V_{OD}$ .

#### **Output Data Rate**

The data is produced at the output at the same rate as it is sampled at the input. The minimum recommended input clock rate for this device is  $f_{CLK(MIN)}$ ; see Converter Electrical Characteristics – AC Electrical Characteristics. However, it is possible to operate the device in 1:2 Demux Mode and capture data from just one 10-bit bus, e.g. just DI (or DId) although both DI and DId are fully operational. This will decimate the data by two and effectively halve the data rate.

#### Terminating RSV Pins

The RSV pins are used for internal purposes. They may be left unconnected and floating or connected as shown in Figure 74.

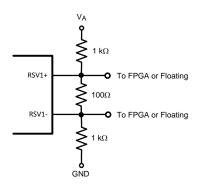


Figure 74. RSV Pin Connection

This board configuration is recommended if the RSV pins are connected to FPGA input pins and must be forced to a known voltage. The value of the  $100\Omega$  resistor should not be changed, but the  $1k\Omega$  resistors may be changed based upon the requirements of the specific FPGA.

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### Terminating Unused LVDS Output Pins

If the ADC is used in Non-Demux Mode, then only the DI and DQ data outputs will have valid data present on them. The DId and DQd data outputs may be left not connected; if unused, they are internally tri-stated.

Similarly, if the Q-channel is powered-down (i.e. PDQ is logic-high), the DQ data output pins, DCLKQ and ORQ should be left not connected.

#### SYNCHRONIZING MULTIPLE ADC10D1000/1500S IN A SYSTEM

The ADC10D1000/1500 has two features to assist the user with synchronizing multiple ADCs in a system; AutoSync and DCLK Reset. The AutoSync feature is new and designates one ADC10D1000/1500 as the Master ADC and other ADC10D1000/1500s in the system as Slave ADCs. The DCLK Reset feature performs the same function as the AutoSync feature, but is the first generation solution to synchronizing multiple ADCs in a system; it is disabled by default. For the application in which there are multiple Master and Slave ADC10D1000/1500s in a system, AutoSync may be used to synchronize the Slave ADC10D1000/1500(s) to each respective Master ADC10D1000/1500 and the DCLK Reset may be used to synchronize the Master ADC10D1000/1500s to each other.

If the AutoSync or DCLK Reset feature is not used, see Table 19 for recommendations about terminating unused pins.

Table 19. Unused AutoSync and DCLK Reset Pin Recommendation

Pin(s)	Unused termination
RCLK+/-	Do not connect.
RCOUT1+/-	Do not connect.
RCOUT2+/-	Do not connect.
DCLK_RST+	Connect to GND via 1kΩ resistor.
DCLK_RST-	Connect to $V_A$ via $1k\Omega$ resistor.

#### AutoSync Feature

AutoSync is a new feature which continuously synchronizes the outputs of multiple ADC10D1000/1500s in a system. It may be used to synchronize the DCLK and data outputs of one or more Slave ADC10D1000/1500s to one Master ADC10D1000/1500. Several advantages of this feature include: no special synchronization pulse required, any upset in synchronization is recovered upon the next DCLK cycle, and the Master/Slave ADC10D1000/1500s may be arranged as a binary tree so that any upset will quickly propagate out of the system.

An example system is shown below in Figure 75 which consists of one Master ADC and two Slave ADCs. For simplicity, only one DCLK is shown; in reality, there is DCLKI and DCLKQ, but they are always in phase with one another.

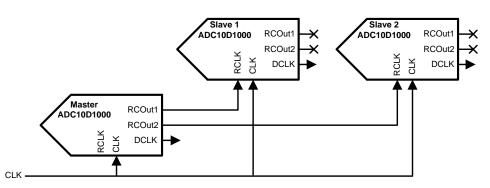


Figure 75. AutoSync Example



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In order to synchronize the DCLK (and Data) outputs of multiple ADCs, the DCLKs must transition at the same time, as well as be in phase with one another. The DCLK at each ADC is generated from the CLK after some latency, plus  $t_{\text{OD}}$  minus  $t_{\text{AD}}$ . Therefore, in order for the DCLKs to transition at the same time, the CLK signal must reach each ADC at the same time. To tune out any differences in the CLK path to each ADC, the  $t_{\text{AD}}$  adjust feature may be used. However, using the  $t_{\text{AD}}$  adjust feature will also affect when the DCLK is produced at the output. If the device is in Demux Mode, then there are four possible phases which each DCLK may be generated on because the typical CLK = 1GHz and DCLK = 250 MHz for this case. The RCLK signal controls the phase of the DCLK, so that each Slave DCLK is on the same phase as the Master DCLK.

The AutoSync feature may only be used via the Control Registers.

#### **DCLK Reset Feature**

The DCLK reset feature is available via ECM, but it is disabled by default. DCLKI and DCLKQ are always synchronized, by design, and do not require a pulse from DCLK\_RST to become synchronized.

The DCLK\_RST signal must observe certain timing requirements, which are shown in Figure 9 of the Timing Diagrams. The DCLK\_RST pulse must be of a minimum width and its deassertion edge must observe setup and hold times with respect to the CLK input rising edge. These timing specifications are listed as t<sub>PWR</sub>, t<sub>SR</sub> and t<sub>HR</sub> and may be found in Converter Electrical Characteristics – AC Electrical Characteristics.

The DCLK\_RST signal can be asserted asynchronously to the input clock. If DCLK\_RST is asserted, the DCLK output is held in a designated state (logic-high) in Demux Mode; in Non-Demux Mode, the DCLK continues to function normally. Depending upon when the DCLK\_RST signal is asserted, there may be a narrow pulse on the DCLK line during this reset event. When the DCLK\_RST signal is de-asserted, there are  $t_{SYNC\_DLY}$  CLK cycles of systematic delay and the next CLK rising edge synchronizes the DCLK output with those of other ADC10D1000/1500s in the system. For 90° Mode (DDRPh = logic-high), the synchronizing edge occurs on the rising edge of CLK, 4 cycles after the first rising edge of CLK after DCLK\_RST is released. For 0° Mode (DDRPh = logic-low), this is 5 cycles instead. The DCLK output is enabled again after a constant delay of  $t_{OD}$ .

For both Demux and Non-Demux Modes, there is some uncertainty about how DCLK comes out of the reset state for the first DCLK\_RST pulse. For the second (and subsequent) DCLK\_RST pulses, the DCLK will come out of the reset state in a known way. Therefore, if using the DCLK Reset feature, it is recommended to apply one "dummy" DCLK\_RST pulse before using the second DCLK\_RST pulse to synchronize the outputs. This recommendation applies each time the device or channel is powered-on.

When using DCLK\_RST to synchronize multiple ADC10D1000/1500s, it is required that the Select Phase bits in the Control Register (Addr: Eh, Bits 3,4) be the same for each Master ADC10D1000/1500.

#### SUPPLY/GROUNDING, LAYOUT AND THERMAL RECOMMENDATIONS

#### **Power Planes**

All supply buses for the ADC should be sourced from a common linear voltage regulator. This ensures that all power buses to the ADC are turned on and off simultaneously. This single source will be split into individual sections of the power plane, with individual decoupling and connection to the different power supply buses of the ADC. Due to the low voltage but relatively high supply current requirement, the optimal solution may be to use a switching regulator to provide an intermediate low voltage, which is then regulated down to the final ADC supply voltage by a linear regulator. Please refer to the documentation provided for the ADC10D1000/1500RB for additional details on specific regulators that are recommended for this configuration.

Power for the ADC should be provided through a broad plane which is located on one layer adjacent to the ground plane(s). Placing the power and ground planes on adjacent layers will provide low impedance decoupling of the ADC supplies, especially at higher frequencies. The output of a linear regulator should feed into the power plane through a low impedance multi-via connection. The power plane should be split into individual power peninsulas near the ADC. Each peninsula should feed a particular power bus on the ADC, with decoupling for that power bus connecting the peninsula to the ground plane near each power/ground pin pair. Using this technique can be difficult on many printed circuit CAD tools. To work around this, zero ohm resistors can be used to connect the power source net to the individual nets for the different ADC power buses. As a final step, the zero ohm resistors can be removed and the plane and peninsulas can be connected manually after all other error checking is completed.

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### **Bypass Capacitors**

The general recommendation is to have one 100nF capacitor for each power/ground pin pair. The capacitors should be surface mount multi-layer ceramic chip capacitors similar to Panasonic part number ECJ-0EB1A104K.

#### **Ground Planes**

Grounding should be done using continuous full ground planes to minimize the impedance for all ground return paths, and provide the shortest possible image/return path for all signal traces.

#### Power System Example

The ADC10D1000/1500RB uses continuous ground planes (except where clear areas are needed to provide appropriate impedance management for specific signals), see Figure 76. Power is provided on one plane, with the 1.9V ADC supply being split into multiple zones or peninsulas for the specific power buses of the ADC. Decoupling capacitors are connected between these power bus peninsulas and the adjacent power planes using vias. The capacitors are located as close to the individual power/ground pin pairs of the ADC as possible. In most cases, this means the capacitors are located on the opposite side of the PCB to the ADC.

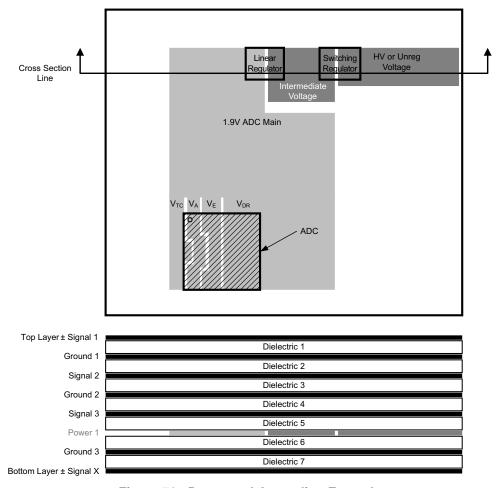


Figure 76. Power and Grounding Example

#### Thermal Management

The Heat Slug Ball Grid Array (NXA) package is a modified version of the industry standard plastic BGA (Ball Grid Array) package. Inside the package, a copper heat spreader cap is attached to the substrate top with exposed metal in the center top area of the package. This results in a 20% improvement (typical) in thermal performance over the standard plastic BGA package.

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ADC10D1000, ADC10D1500

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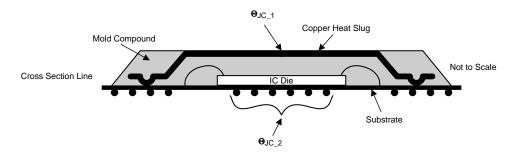


Figure 77. HSBGA (NXA) Conceptual Drawing

The center balls are connected to the bottom of the die by vias in the package substrate, Figure 77. This gives a low thermal resistance between the die and these balls. Connecting these balls to the PCB ground planes with a low thermal resistance path is the best way dissipate the heat from the ADC. These pins should also be connected to the ground plane via a low impedance path for electrical purposes. The direct connection to the ground planes is an easy method to spread heat away from the ADC. Along with the ground plane, the parallel power planes will provide additional thermal dissipation.

The center ground balls should be soldered down to the recommended ball pads (See AN-1126). These balls will have wide traces which in turn have vias which connect to the internal ground planes, and a bottom ground pad/pour if possible. This ensures a good ground is provided for these balls, and that the optimal heat transfer will occur between these balls and the PCB ground planes.

In spite of these package enhancements, analysis using the standard JEDEC JESD51-7 four-layer PCB thermal model shows that ambient temperatures must be limited to a max of 70°C to ensure a safe operating junction temperature for the ADC10D1500. However, most applications using the ADC10D1500 will have a printed circuit board which is more complex than that used in JESD51-7. Typical circuit boards will have more layers than the JESD51-7 (eight or more), several of which will be used for ground and power planes. In those applications, the thermal resistance parameters of the ADC10D1500 and the circuit board can be used to determine the actual safe ambient operating temperature up to a maximum of 85°C.

Three key parameters are provided to allow for modeling and calculations. Because there are two main thermal paths between the ADC die and external environment, the thermal resistance for each of these paths is provided.  $\theta_{JC1}$  represents the thermal resistance between the die and the exposed metal area on the top of the HSBGA package.  $\theta_{JC2}$  represents the thermal resistance between the die and the center group of balls on the bottom of the HSBGA package. The final parameter is the allowed maximum junction temperature, which is 138°C.

In other applications, a heat sink or other thermally conductive path can be added to the top of the HSBGA package to remove heat. In those cases,  $\theta_{JC1}$  can be used along with the thermal parameters for the heat sink or other thermal coupling added. Representative heat sinks which might be used with the ADC10D1000/1500 include the Cool Innovations p/n 3-1212XXG and similar products from other vendors. In many applications, the printed circuit board will provide the primary thermal path conducting heat away from the ADC package. In those cases,  $\theta_{JC2}$  can be used in conjunction with printed circuit board thermal modeling software to determine the allowed operating conditions that will maintain the die temperature below the maximum allowable limit. Additional dissipation can be achieved by coupling a heat sink to the copper pour area on the bottom side of the printed circuit board.

Typically, dissipation will occur through one predominant thermal path. In these cases, the following calculations can be used to determine the maximum safe ambient operating temperature:

$$T_{J} = T_{A} + P_{D} \times (\theta_{JC} + \theta_{CA})$$

$$138^{\circ}C = T_{A} + 3.98W \times (\theta_{JC} + \theta_{CA})$$

For  $\theta_{JC}$ , the value for the primary thermal path in the given application environment should be used ( $\theta_{JC1}$  or  $\theta_{JC2}$ ).  $\theta_{CA}$  is the thermal resistance from the case to ambient, which would typically be that of the heat sink used. Using this relationship and the desired ambient temperature, the required heat sink thermal resistance can be found. Alternately, the heat sink thermal resistance can be used to find the maximum ambient temperature. For more complex systems, thermal modeling software can be used to evaluate the printed circuit board system and determine the expected junction temperature given the total system dissipation and ambient temperature.

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### SYSTEM POWER-ON CONSIDERATIONS

There are a couple important topics to consider associated with the system power-on event including configuration and calibration, and the Data Clock.

#### Power-on, Configuration, and Calibration

Following the application of power to the ADC10D1000/1500, several events must take place before the output from the ADC10D1000/1500 is valid and at full performance; at least one full calibration must be executed with the device configured in the desired mode.

Following the application of power to the ADC10D1000/1500, there is a delay of  $t_{CalDly}$  and then the Power-on Calibration is executed. This is why it is recommended to set the CalDly Pin via an external pull-up or pull-down resistor. Then, the state of that input will be determined at the same time that power is applied to the ADC and  $t_{CalDly}$  will be a known quantity. For the purpose of this section, it is assumed that CalDly is set as recommended.

The Control Bits or Pins must be set or written to configure the ADC10D1000/1500 in the desired mode. This must take place via either Extended Control Mode or Non-ECM (Pin Control Mode) before subsequent calibrations will yield an output at full performance in that mode. Some examples of modes include DES/Non-DES Mode, Demux/Non-demux Mode, and Full-Scale Range.

The simplest case is when device is in Non-ECM and the Control Pins are set by pull-up/down resistors, see Figure 78. For this case, the settings to the Control Pins ramp concurrently to the ADC voltage. Following the delay of  $t_{CalDly}$  and the calibration execution time,  $t_{CAL}$ , the output of the ADC10D1000/1500 is valid and at full performance. If it takes longer than  $t_{CalDly}$  for the system to stabilize at its operating temperature, it is recommended to execute an on-command calibration at that time.

Another case is when the FPGA writes to the Control Pins (Non-ECM) or to the SPI (ECM), see Figure 79. It is always necessary to comply with the Operating Ratings and Absolute Maximum ratings, i.e. the Control Pins may not be driven below the ground or above the supply, regardless of what the voltage currently applied to the supply is. Therefore, it is not recommended to write to the Control Pins or SPI before power is applied to the ADC10D1000/1500. As long as the FPGA has completed writing to the Control Pins or SPI, the Power-on Calibration will result in a valid output at full performance. Once again, if it takes longer than  $t_{CalDly}$  for the system to stabilize at its operating temperature, it is recommended to execute an on-command calibration at that time.

Due to system requirements, it may not be possible for the FPGA to write to the Control Pins or SPI before the Power-on Calibration takes place, see Figure 80. It is not critical to configure the device before the Power-on Calibration, but it is critical to realize that the output for such a case is not at its full performance. Following an On-command Calibration, the device will be at its full performance.

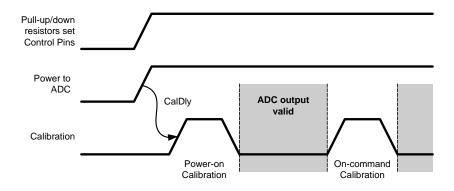


Figure 78. Power-on with Control Pins set by Pull-up/down Resistors

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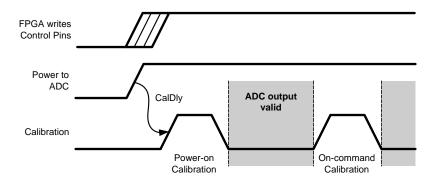


Figure 79. Power-on with Control Pins set by FPGA pre Power-on Cal

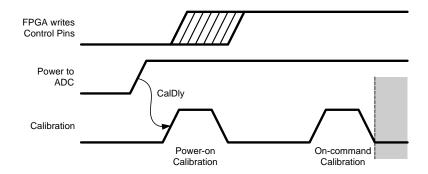


Figure 80. Power-on with Control Pins set by FPGA post Power-on Cal

#### Power-on and Data Clock (DCLK)

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Many applications use the DCLK output for a system clock. For the ADC10D1000/1500, each I- and Q-channel has its own DCLKI and DCLKQ, respectively. The DCLK output is always active, unless that channel is powereddown or the DCLK Reset feature is used while the device is in Demux Mode. As the supply to the ADC10D1000/1500 ramps, the DCLK also comes up, see this example from the ADC10D1000/1500RB: Figure 81. While the supply is too low, there is no output at DCLK. As the supply continues to ramp, DCLK functions intermittently with irregular frequency, but the amplitude continues to track with the supply. Much below the low end of operating supply range of the ADC10D1000/1500, the DCLK is already fully operational.

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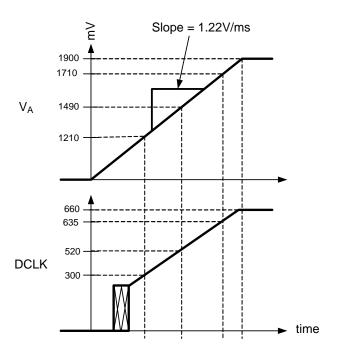


Figure 81. Supply and DCLK Ramping

#### **RECOMMENDED SYSTEM CHIPS**

TI recommends these other chips including temperature sensors, clocking devices, and amplifiers in order to support the ADC10D1000/1500 in a system design.

#### Temperature Sensor

The ADC10D1000/1500 has an on-die temperature diode connected to pins Tdiode+/- which may be used to monitor the die temperature. TI also provides a family of temperature sensors for this application which monitor different numbers of external devices, see Table 20.

**Table 20. Temperature Sensor Recommendation** 

Number of External Devices Monitored	Recommended Temperature Sensor
1	LM95235
2	LM95213
4	LM95214

The temperature sensor (LM95235/13/14) is an 11-bit digital temperature sensor with a 2-wire System Management Bus (SMBus) interface that can monitor the temperature of one, two, or four remote diodes as well as its own temperature. It can be used to accurately monitor the temperature of up to one, two, or four external devices such as the ADC10D1000/1500, a FPGA, other system components, and the ambient temperature.

The temperature sensor reports temperature in two different formats for +127.875°C/-128°C range and 0°/255°C range. It has a Sigma-Delta ADC core which provides the first level of noise immunity. For improved performance in a noise environment, the temperature sensor includes programmable digital filters for Remote Diode temperature readings. When the digital filters are invoked, the resolution for the Remote Diode readings increases to 0.03125°C. For maximum flexibility and best accuracy, the temperature sensor includes offset registers that allow calibration of other diode types.

Diode fault detection circuitry in the temperature sensor can detect the absence or fault state of a remote diode: whether D+ is shorted to the power supply, D- or ground, or floating.

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In the following of a typical application, the LM95213 is used to monitor the temperature of an ADC10D1000/1500 as well as a FPGA, see Figure 82.

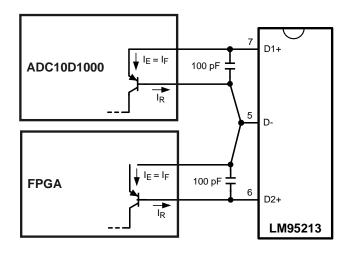


Figure 82. Typical Temperature Sensor Application

#### Clocking Device

The clock source can be a PLL/VCO device such as the LMX2531LQxxxx family of products. The specific device should be selected according to the desired ADC sampling clock frequency. The ADC10D1000/1500RB uses the LMX2531LQ1510E, with the ADC clock source provided by the Aux PLL output. Other devices which may be considered based on clock source, jitter cleaning, and distribution purposes are the LMK01XXX, LMK02XXX, LMK03XXX and LMK04XXX product families.

#### **Amplifier**

The following amplifiers can be used for ADC10D1000/1500 applications which require DC coupled input or signal gain, neither of which can be provided with a transformer coupled input circuit:

AmplifierBandwidthBrief featuresLMH65521.5 GHzConfigurable gainLMH6553900 MHzOutput clamp and configurable gainLMH65542.5 GHzConfigurable gainLMH65551.2 GHzFixed gain

**Table 21. Amplifier Recommendation** 

#### **Register Definitions**

Ten read/write registers provide several control and configuration options in the Extended Control Mode. These registers have no effect when the device is in the Non-extended Control Mode. Each register description below also shows the Power-On Reset (POR) state of each control bit. See Table 22 for a summary. For a description of the functionality and timing to read/write the control registers, see The Serial Interface.

**Table 22. Register Addresses** 

А3	A2	A1	A0	Hex	Register Addressed
0	0	0	0	0 <b>h</b>	Configuration Register 1
0	0	0	1	1h	V <sub>CMO</sub> Adjust
0	0	1	0	2h	I-channel Offset
0	0	1	1	3h	I-channel FSR
0	1	0	0	4h	Calibration Adjust
0	1	0	1	5 <b>h</b>	Reserved

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71



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#### Table 22. Register Addresses (continued)

0	1	1	0	6h	Reserved
0	1	1	1	7h	Reserved
1	0	0	0	8 <b>h</b>	Reserved
1	0	0	1	9 <b>h</b>	Reserved
1	0	1	0	Ah	Q-channel Offset
1	0	1	1	Bh	Q-channel FSR
1	1	0	0	Ch	Aperture Delay Coarse Adjust
1	1	0	1	D <b>h</b>	Aperture Delay Fine Adjust and LC Filter Adjust
1	1	1	0	Eh	AutoSync
1	1	1	1	Fh	Reserved

#### **Table 23. Configuration Register 1**

Addr: 0h (0000b)								POR state: 2000h							: 2000 <b>h</b>	
Bit	Bit 15 14 13 12 11 10 9 8							8	7	6	5	4	3	2	1	0
Name	CAL	DPS	ovs	TPM	PDI	PDQ	Res	LFS	DES	DEQ	DIQ	2SC	Res			
POR	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 3:0	Reserved. Must be set to 0b.
Bit 4	2SC: Two's Complement output. For the default setting of 0b, the data is output in Offset Binary format; when set to 1b, the data is output in Two's Complement format.
Bit 5	DIQ: DES I- and Q-input, a.k.a. DESIQ Mode. When in DES Mode, setting this bit to 1b shorts the I- and Q-inputs. If the bit is left at its default 0b, the I- and Q-inputs remain electrically separate. To operate the device in DESIQ Mode, Bits<7:5> must be set to 101b. In this mode, both the I- and Q-inputs must be externally driven.
Bit 6	DEQ: DES Q-input select, a.k.a. DESQ Mode. When the device is in DES Mode, this bit can select the input that the device will operate on. The default setting of 0b selects the I-input and 1b selects the Q-input.
Bit 7	DES: Dual-Edge Sampling Mode select. When this bit is set to 0b, the device will operate in the Non-DES Mode; when it is set to 1b, the device will operate in the DES Mode. See DES/Non-DES Mode for more information.
Bit 8	LFS: Low-Frequency Select. If the sampling clock (CLK) is at or below 300 MHz, set this bit to 1b.
Bit 9	Reserved. Must be set to 0b.
Bit 10	PDQ: Power-down Q-channel. When this bit is set to 0b, the Q-channel is fully operational, but when it is set to 1b, the Q-channel is powered-down. The Q-channel may be powered-down via this bit or the PDQ Pin, which is active, even in ECM.
Bit 11	PDI: Power-down I-channel. When this bit is set to 0b, the I-channel is fully operational, but when it is set to 1b, the I-channel is powered-down. The I-channel may be powered-down via this bit or the PDI Pin, which is active, even in ECM.
Bit 12	TPM: Test Pattern Mode. When this bit is set to 1b, the device will continually output a fixed digital pattern at the digital Data and OR outputs. When set to 0b, the device will continually output the converted signal, which was present at the analog inputs. See Test Pattern Mode for details about the TPM pattern.
Bit 13	OVS: Output Voltage Select. This bit sets the differential voltage level for the LVDS outputs including Data, OR, and DCLK. 0b selects the lower level and 1b selects the higher level. See V <sub>OD</sub> in Converter Electrical Characteristics – Digital Control and Output Pin Characteristicsfor details.
Bit 14	DPS: DDR Phase Select. Set this bit to 0 <b>b</b> to select the 0° Mode DDR Data-to-DCLK phase relationship and to 1 <b>b</b> to select the 90° Mode. This bit has no effect when the device is in Non-Demux Mode.
Bit 15	CAL: Calibration Enable. When this bit is set to 1b, an on-command calibration is initiated. This bit is not reset automatically upon completion of the calibration. Therefore, the user must reset this bit to 0b and then set it to 1b again to execute another calibration. This bit is logically OR'd with the CAL Pin; both bit and pin must be set to 0b before either is used to execute a calibration.

Product Folder Links: ADC10D1000 ADC10D1500

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

#### Table 24. V<sub>CMO</sub> Adjust

Addr: 1 <b>h</b> (0001 <b>b</b> )									POR state: 2A00h							2A00 <b>h</b>
Bit	15 14 13 12 11 10 9 8								7	6	5	4	3	2	1	0
Name	ne Res								,	VCA(2:0	)			Res		
POR	0	0	1	0	1	0	1	0	0	0	0	0	0	0	0	0

Bits 15:8	Reserved. Must be set as shown.											
Bits 7:5	VCA(2:0): $V_{CMO}$ Adjust. Adjusting from the default VCA(2:0) = 0d to VCA(2:0) = 7d decreases $V_{CMO}$ from it's typical value (see $V_{CMO}$ in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics) to 1.05V by increments of ~28.6 mV.											
	Code	Code V <sub>CMO</sub>										
	000 (default)	V <sub>CMO</sub>										
	100	V <sub>CMO</sub> - 114 mV										
	111 V <sub>CMO</sub> - 200 mV											
Bits 4:0	Reserved. Must be set as shown.											

#### Table 25. I-channel Offset Adjust

Addr: 2h (0010b)								POR state: 0000h								
Bit	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1 0						0	
Name		Res		os		OM(11:0)									•	
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 15:13	Reserved. Must be set to 0b.									
Bit 12	OS: Offset Sign. The default setting of 0b incurs a positive offset of a magnitude set by Bits 11:0 to the ADC output. Setting this bet to 1b incurs a negative offset of the set magnitude.									
Bits 11:0		OM(11:0): Offset Magnitude. These bits determine the magnitude of the offset set at the ADC output (straight binary coding). The range is from 0 mV for OM(11:0) = 0 <b>d</b> to 45 mV for OM(11:0) = 4095 <b>d</b> in steps of ~11 $\mu$ V. Monotonicity is specified by design only for the 9 MSBs.								
	Code	Offset [mV]								
	0000 0000 0000 (default)	0								
	1000 0000 0000 22.5									
	1111 1111 1111	45								

#### Table 26. I-channel Full Scale Range Adjust

Addr: 3h (0011b)													PC	OR state	: 4000 <b>h</b>	
Bit	15	14	14 13 12 11 10 9 8								5	4	3	2	1	0
Name	Res		FM(14:0)													
POR	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit 15	Reserved. Must be set to 0b.							
Bits 14:0	600 mV (0d) to 980 mV (32767d) with the default setting 9 MSBs. The mid-range (low) setting in ECM correspon	C full-scale range magnitude (straight binary coding.) The range is from g at 790 mV (16384 <b>d</b> ). Monotonicity is specified by design only for the ds to the nominal (low) setting in Non-ECM. A greater range of FSR mV. See V <sub>IN_FSR</sub> in Converter Electrical Characteristics – Analog vization details.						
	Code FSR [mV]							
	000 0000 0000 0000	600						
	100 0000 0000 (default) 790							
	111 1111 1111 1111 980							

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

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#### **Table 27. Calibration Adjust**

Addr: 4	h (0100l	<b>o</b> )												PO	R state:	DA7F <b>h</b>
Bit	<b>Bit</b> 15 14 13 12 11 10 9 8								7	6	5	4	3	2	1	0
Name	Res	CSS		Res			CMS	3(1:0)	SSC				Res			•
POR	1	1	0	1	1	0	1	0	0	1	1	1	1	1	1	1

Bit 15	Reserved. Must be set as shown.
Bit 14	CSS: Calibration Sequence Select. The default $1\mathbf{b}$ selects the following calibration sequence: reset all previously calibrated elements to nominal values, do $R_{IN}$ Calibration, do internal linearity Calibration. Setting CSS = $0\mathbf{b}$ selects the following calibration sequence: do not reset $R_{IN}$ to its nominal value, skip $R_{IN}$ calibration, do internal linearity Calibration. The calibration must be completed at least one time with CSS = $1\mathbf{b}$ to calibrate $R_{IN}$ . Subsequent calibrations may be run with CSS = $0\mathbf{b}$ (skip $R_{IN}$ calibration) or $1\mathbf{b}$ (full $R_{IN}$ and internal linearity Calibration).
Bits 13:10	Reserved. Must be set as shown.
Bits 9:8	CMS(1:0): Calibration Mode Select. These bits affect the length of time taken to calibrate the internal linearity. See t <sub>CAL</sub> in Converter Electrical Characteristics – AC Electrical Characteristics.
Bit 7	SSC: SPI Scan Control. Setting this control bit to 1b allows the calibration values, stored in Addr: 5h, to be read/written. When not reading/writing the calibration values, this control bit should left at its default 0b setting.
Bits 6:0	Reserved. Must be set as shown.

#### **Table 28. Calibration Values**

Addr: 5	Addr: 5h (0101b)													РО	R state:	XXXXh
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	SS(15:0)															
POR	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х

Bits 15:0 SS(15:0): SPI Scan. When the ADC performs a self-calibration, the values for the calibration are stored in this register and may be read from/ written to it. Set SSC (Addr: 4h, Bit 7) to read/write.

#### Table 29. Reserved

Addr: 6	h (0110 <b>l</b>	<b>o</b> )												PC	OR state:	1C70 <b>h</b>
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name		Res														
POR	0	0	0	1	1	1	0	0	0	1	1	1	0	0	0	0

Bits 15:0 Reserved. Must be set as shown.

#### Table 30. Reserved

Addr: 7	h (0111k	<b>)</b>												P(	OR state	: 0000 <b>h</b>
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	ne Res															
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 15:0 Reserved. Must be set as shown.

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#### Table 31. Reserved

Addr: 8	<b>h</b> (1000 <b>k</b>	<b>o</b> )												PO	OR state	: 0000 <b>h</b>
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	Res															
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 15:0 Reserved. Must be set as shown.

#### Table 32. Reserved

Addr: 9	h (1001l	<b>o</b> )												P(	OR state	: 0000 <b>h</b>
Bit	15 14 13 12 11 10 9 8									6	5	4	3	2	1	0
Name	Res															
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 15:0 Reserved. Must be set as shown.

#### Table 33. Q-channel Offset Adjust

Addr: A	Addr: A <b>h</b> (1010 <b>b</b> )													PC	OR state	: 0000 <b>h</b>
Bit	15 14 13 12 11 10 9 8					8	7	6	5	4	3	2	1	0		
Name	e Res OS								OM(	11:0)	•	•	•		•	
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bits 15:13	Reserved. Must be set to 0b.							
Bit 12	OS: Offset Sign. The default setting of 0 this bet to 1b incurs a negative offset of	Ob incurs a positive offset of a magnitude set by Bits 11:0 to the ADC output. Setting f the set magnitude.						
Bits 11:0	OM(11:0): Offset Magnitude. These bits determine the magnitude of the offset set at the ADC output (straight binary coding). The range is from 0 mV for OM(11:0) = 0 <b>d</b> to 45 mV for OM(11:0) = 4095 <b>d</b> in steps of ~11 $\mu$ V. Monotonicity is specified by design only for the 9 MSBs.							
	Code	Offset [mV]						
	0000 0000 0000 (default)	0						
	1000 0000 0000	22.5						
	1111 1111 1111	45						

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#### Table 34. Q-channel Full-Scale Range Adjust

Addr: B	Addr: Bh (1011b)													P	OR state	: 4000 <b>h</b>
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	Res		FM(14:0)													
POR	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit 15	Reserved. Must be set to 0b.							
Bits 14:0	FM(14:0): FSR Magnitude. These bits increase the ADC full-scale range magnitude (straight binary coding.) The range is 600 mV (0d) to 980 mV (32767d) with the default setting at 790 mV (16384d). Monotonicity is specified by design only for 9 MSBs. The mid-range (low) setting in ECM corresponds to the nominal (low) setting in Non-ECM. A greater range of FS values is available in ECM, i.e. FSR values above 790 mV. See V <sub>IN_FSR</sub> in Converter Electrical Characteristics – Analog Input/Output and Reference Characteristics for characterization details.							
	Code	FSR [mV]						
	000 0000 0000 0000	600						
	100 0000 0000 0000 (default)	790						
	111 1111 1111 1111	980						

#### **Table 35. Aperture Delay Coarse Adjust**

Addr: C	Addr: Ch (1100b)													PC	OR state	: 0004 <b>h</b>
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	CAM(11:0)												STA	DCC	R	es
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0

Bits 15:4	CAM(11:0): Coarse Adjust Magnitude. This 12-bit value determines the amount of delay that will be applied to the input CLK signal. The range is 0 ps delay for CAM(11:0) = 0d to a maximum delay of 825 ps for CAM(11:0) = 2431d (±95 ps due to PVT variation) in steps of ~340 fs. For code CAM(11:0) = 2432d and above, the delay saturates and the maximum delay applies. Additional, finer delay steps are available in register Dh. Either STA (Bit 3) or SA (Addr: Dh, Bit 8) must be selected to enable this function.
Bit 3	STA: Select t <sub>AD</sub> Adjust. Set this bit to 1 <b>b</b> to enable the t <sub>AD</sub> adjust feature, which will make both coarse and fine adjustment settings, i.e. CAM(11:0) and FAM(5:0), available.
Bit 2	DCC: Duty Cycle Correct. This bit can be set to 0b to disable the automatic duty-cycle stabilizer feature of the chip. This feature is enabled by default.
Bits 1:0	Reserved. Must be set to 0b.

#### Table 36. Aperture Delay Fine Adjust and LC Filter Adjust

Addr: D	Addr: Dh (1101b)										POR state: 0000h								
<b>Bit</b> 15 14 13 12 11 10						9	8	7 6 5 4 3 2 1 0							0				
Name	FAM(5:0) Res SA							SA				LCF	(7:0)						
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			

Bits 15:10	FAM(5:0): Fine Aperture Adjust Magnitude. This 6-bit value determines the amount of additional delay that will be applied to the input CLK when the Clock Phase Adjust feature is enabled via STA (Addr: Ch, Bit 3) or SA (Addr: Dh, Bit 8). The range is straight binary from 0 ps delay for FAM(5:0) = 0d to 2.3 ps delay for FAM(5:0) = 63d (±300 fs due to PVT variation) in steps of ~36 fs.
Bit 9	Reserved. Must be set to 0b.
Bit 8	SA: Select $t_{AD}$ and LC filter Adjust. Set this bit to 1 <b>b</b> to enable the $t_{AD}$ and LC filter adjust features. Using this bit is the same as enabling STA (Addr: Ch, Bit 3), but also enables the LC filter to clean the clock jitter. If SA is enabled, then the value of the STA bit is ignored.
Bits 7:0	LCF(7:0): LC tank select Frequency. Use these bits to select the center frequency of the LC filter on the clock input. The range is from 0.8 GHz (255 <b>d</b> ) to 1.5 GHz (0 <b>d</b> ). Note that the tuning range is not binary encoded, and the eight bits are thermometer encoded, i.e. the mid value of 1.1 GHz tuning is achieved with LCF(7:0) = 0000 1111 <b>b</b> .

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SNAS462Q - OCTOBER 2008-REVISED MARCH 2013

#### Table 37. AutoSync

Addr: E	Addr: Eh (1110b)													P(	OR state	: 0003 <b>h</b>
Bit	Bit 15 14 13 12 11 10 9								7	6	5	4	3	2	1	0
Name		DRC(9:0)									Res	SP(	1:0)	ES	DOC	DR
POR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1

Bits 15:6	DRC(9:0): Delay Reference Clock (9:0). These bits may be used to increase the delay on the input reference clock when synchronizing multiple ADCs. The minimum delay is 0s (0d) to 1000 ps (639d). The delay remains the maximum of 1000 ps for any codes above or equal to 639d.
Bit 5	Reserved. Must be set to 0b.
Bits 4:3	SP(1:0): Select Phase. These bits select the phase of the reference clock which is latched. The codes correspond to the following phase shift: $00 = 0^{\circ}$ $01 = 90^{\circ}$ $10 = 180^{\circ}$ $11 = 270^{\circ}$
Bit 2	ES: Enable Slave. Set this bit to 1b to enable the Slave Mode of operation. In this mode, the internal divided clocks are synchronized with the reference clock coming from the master ADC. The master clock is applied on the input pins RCLK. If this bit is set to 0b, then the device is in Master Mode.
Bit 1	DOC: Disable Output reference Clocks. Setting this bit to 0b sends a CLK/4 signal on RCOut1 and RCOut2. The default setting of 1b disables these output drivers. This bit functions as described, regardless of whether the device is operating in Master or Slave Mode, as determined by ES (Bit 2).
Bit 0	DR: Disable Reset. The default setting of 1b leaves the DCLK_RST functionality disabled. Set this bit to 0b to enable DCLK_RST functionality.

#### Table 38. Reserved

Addr: F	h (1111 <b>l</b>	<b>o</b> )					POR state: 000Cl									
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Name	Res															
POR	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0

Bits 15:0
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SNAS462Q-OCTOBER 2008-REVISE	ED MARCH 2013
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### REVISION HISTORY

	REVISION HISTORY									
C	changes from Revision P (March 2013) to Revision Q	Page								
•	Changed layout of National Data Sheet to TI format	71								

78



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PACKAGE OPTION ADDENDUM

29-Jan-2016

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
ADC10D1000CIUT	ACTIVE	BGA	NXA	292	40	TBD	Call TI	Call TI	-40 to 85	ADC10D1000 CIUT	Samples
ADC10D1000CIUT/NOPB	ACTIVE	BGA	NXA	292	40	Green (RoHS & no Sb/Br)	SNAG	Level-3-250C-168 HR	-40 to 85	ADC10D1000 CIUT	Samples
ADC10D1500CIUT	ACTIVE	BGA	NXA	292	40	TBD	Call TI	Call TI	-40 to 85	ADC10D1500 CIUT	Samples
ADC10D1500CIUT/NOPB	ACTIVE	BGA	NXA	292	40	Green (RoHS & no Sb/Br)	SNAG	Level-3-250C-168 HR	-40 to 85	ADC10D1500 CIUT	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: Tl has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Addendum-Page 1



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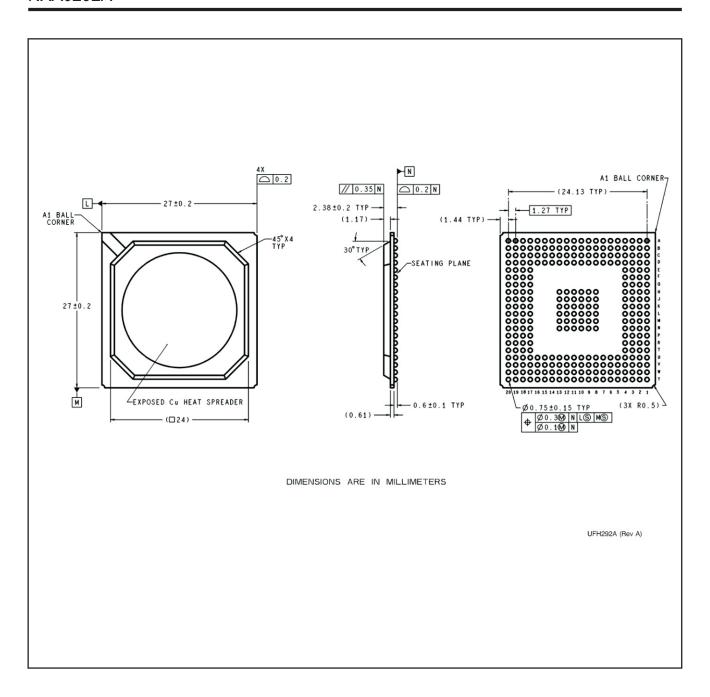
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Addendum-Page 2			



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### NXA0292A







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